

## Speedstack 2021 - 2024 Updates

## Richard Attrill – January 2024 (Rev 13)



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## Speedstack v24.01.01 (Jan 2024)



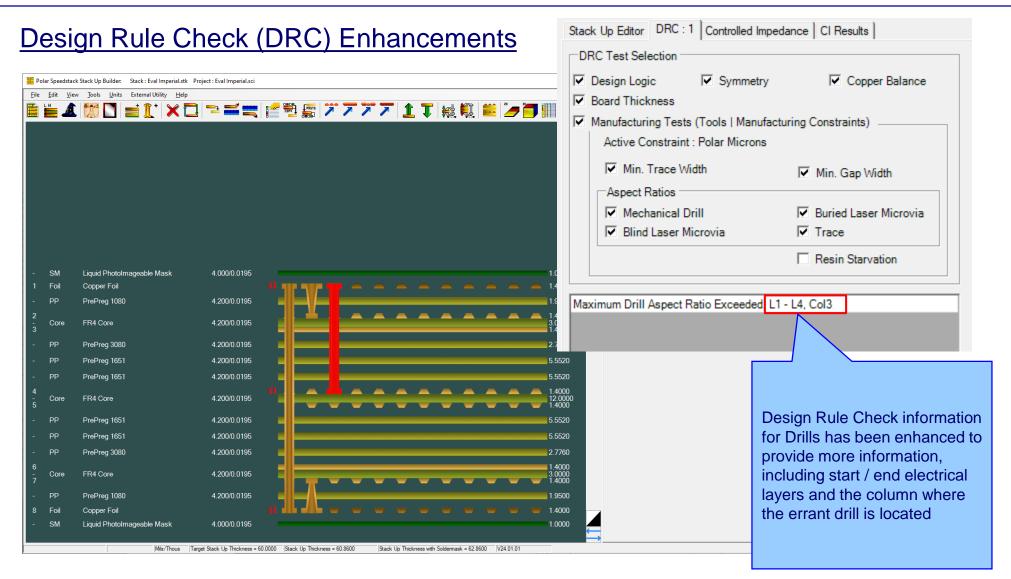
### **Enhancements**

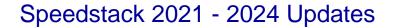
 From 2024 Speedstack will be running on the Microsoft .Net Framework 4.8. It has migrated as a result of customer IT policy requests and we are working on new functionality for releases later in Q1 based on this new platform



## Speedstack v23.09.01 (Sept 2023)









### Other enhancements

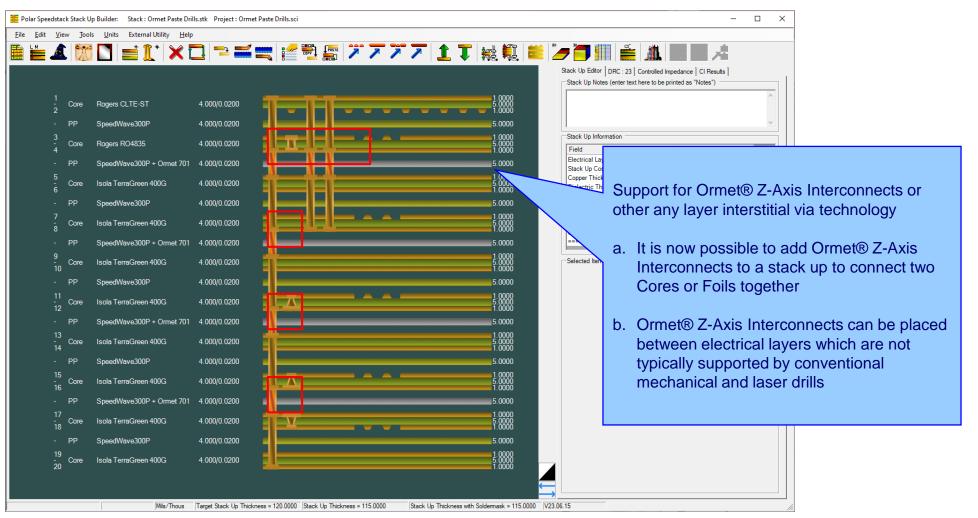
- Printing: Improvements to the Solder Mask to Solder Mask thickness line, particularly when an ident / coverlay / peelable material is above or below the Solder Mask
- Printing: Bill of Materials (BOM) table enhancements including options to enable / disable Number of Panels, Circuits Per Panel, Cost Per Circuit that appear under BOM table
- Editor: Multi-selected materials will now stay selected when right-mouse menu is used to bring up context menu



## Speedstack v23.06.15 (June 2023)



## Drill Enhancements including support for Ormet® Z-Axis Interconnects or other any layer interstitial via technology





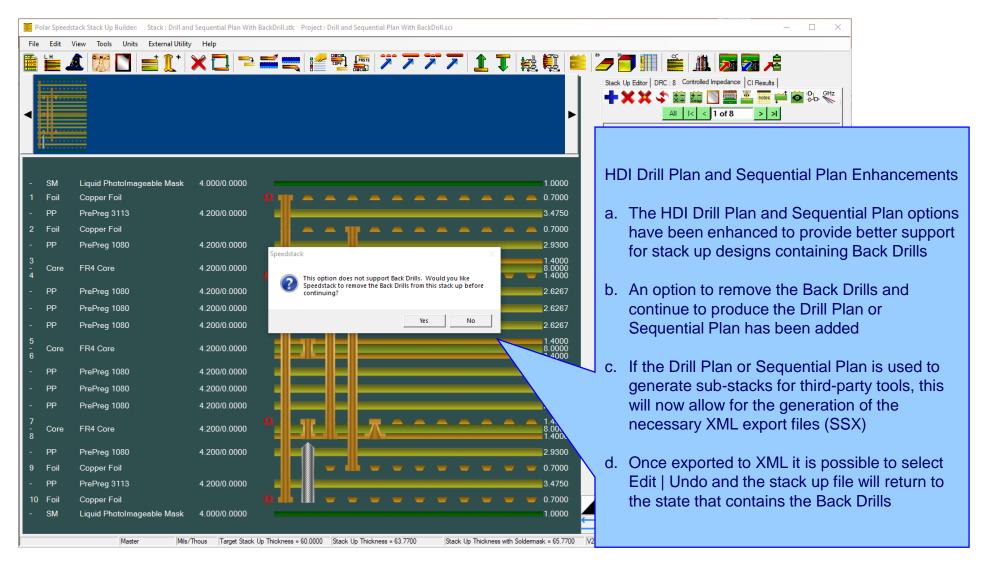
# Enhancements including support for Ormet® Z-Axis Interconnects or other any layer interstitial via technology

Configuration Options	×
External Utilities       Rebuild and Calculate Structures         General       Structure Defaults       Licensing         File       Locations       Goal Seeking       User       CITS Test       Colours       Miscellaneous	Defaults
Number of Undo Levels     5       Maximum Laser Drilled Layers     5	
Drill Validation Check This option prevents invalid drills from being added to the stack up. For instance, a drill that starts from the lower copper sid materials. Uncheck this option if you use a drilling technology that permits drills to be placed between electrical layers which typically supported by conventional mechanical and laser drills	le of core h are not
	Support for Ormet® Z-Axis Interconnects or other any layer interstitial via technology (continued)
Appl	A new Tools   Options   Miscellaneous tab Drill Validation Check option has been introduced. Unchecking this option will disable the Speedstack invalid drills check in order to support the Ormet® Z-Axis Interconnects technology
	•••

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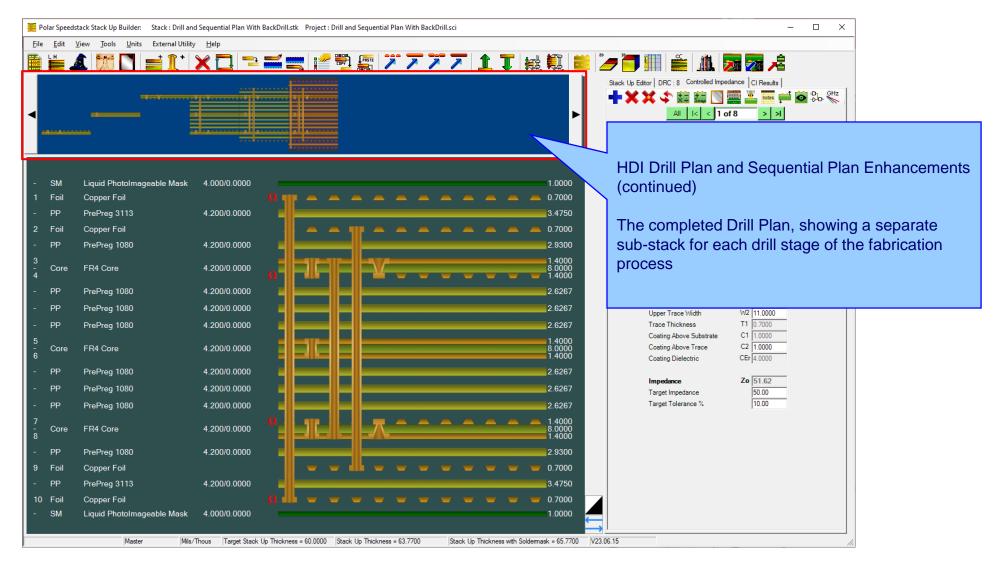


## HDI Drill Plan and Sequential Plan Enhancements





### HDI Drill Plan and Sequential Plan Enhancements

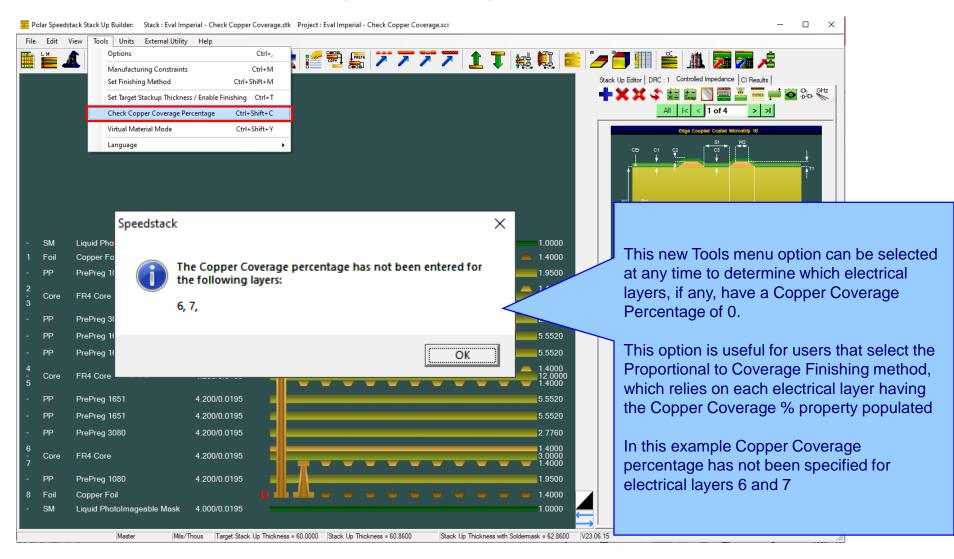




## Speedstack v23.05.01 (May 2023)



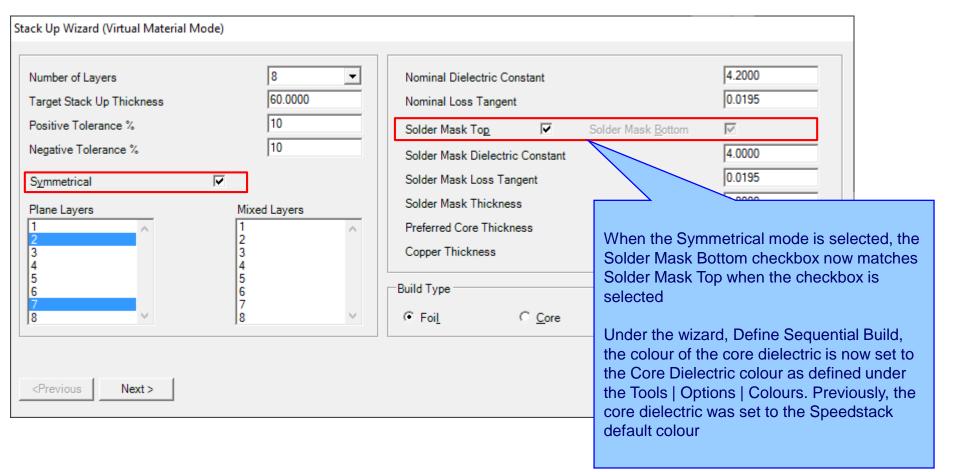
## New Check Copper Coverage Percentage option



13

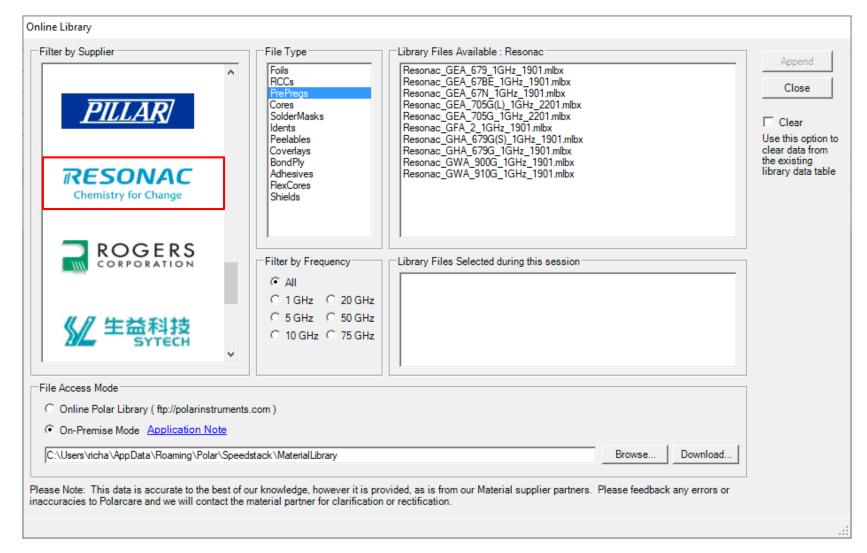


### Virtual Material Wizard Improvements





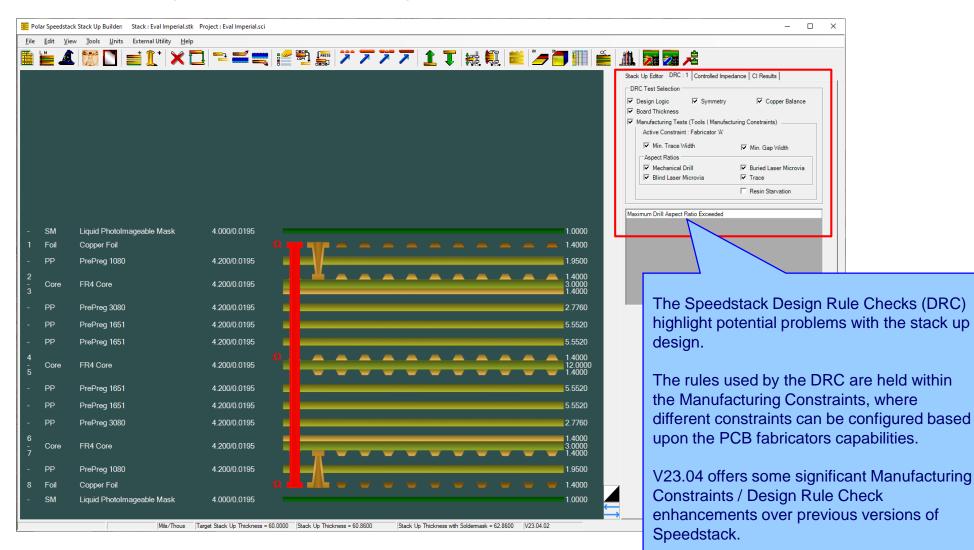
## Resonac materials added to the Online Library





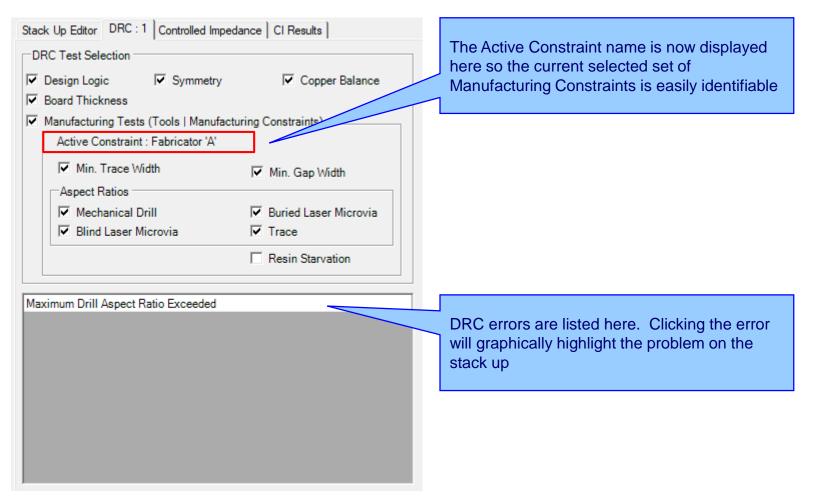
## Speedstack v23.04.02 (April 2023)



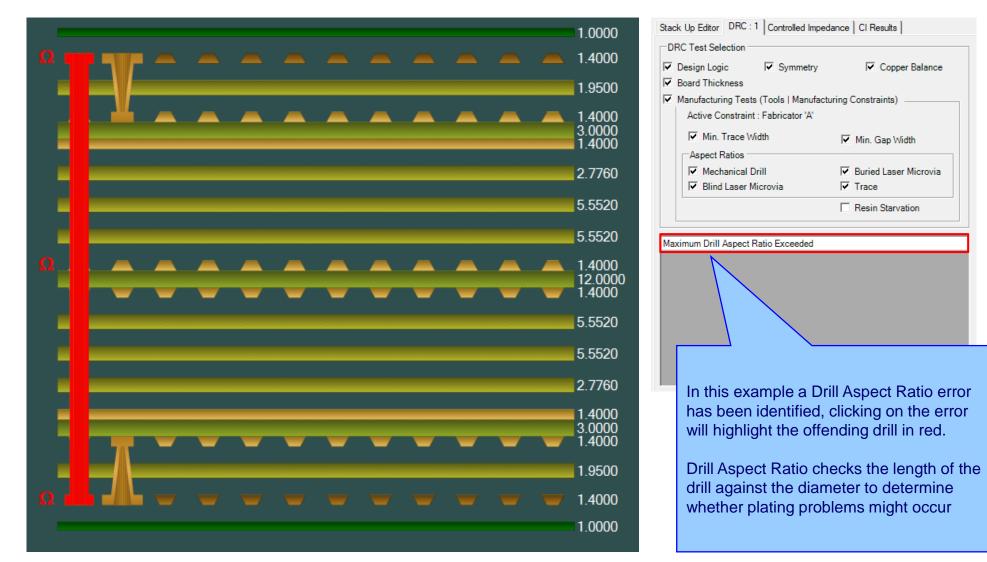


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onstraint : Fabricator 'A'							
Manufacturer's Name	Blind Laser Via A. R.	Buried Laser Via A.	Mechanical Drill A. R.	Minimum Gap	Minimum Trace Width	Trace A. R.	Units
Polar Microns	0.5	0.5	8.5	75	75	1	Microns
Polar Mils	0.5	0.5	8.5	3	3	1	Mils
Polar Millimetres	0.5	0.5	8.5	0.075	0.075	1	Millimetres
Polar Inches	0.5	0.5	8.5	0.003	0.003	1	Inches
Fabricator 'A'	0.5	0.5	6	3	3	1	Mils
ons: Double-Click the Data Grid r	row to edit, add or delete a	constraint					
	row to edit, add or delete a	e constraint					
ight and Set Active Constraint	row to edit, add or delete a	a constraint			The Tools   Manu option provides o Edit the constrain	options to Ad nts. Multiple	dd, Delete e sets of
ions: Double-Click the Data Grid r ight and Set Active Constraint Highlight		active constrai electing the	nt is		option provides of	options to Ad nts. Multiple upported, a to be check ors capabilit	dd, Delete e sets of llowing the ed against ies.



## Manufacturing Constraints / Design Rule Check Enhancements

Manufacturing Constraints		Edit Constraints		7		
Active Constraint : Fabricator 'A'		-Units				
Manufacturer's Name	Blind Laser Via A. R. Buried	• Mils	C Microns	Width	Trace A. R.	Units
Polar Microns	0.5	C Inches	C Millimetres		1	Microns
Polar Mils	0.5				1	Mils
Polar Millimetres	0.5	0 / N			1	Millimetres
Polar Inches	0.5	Option Name	Fabricator 'A'		1	Inches
Fabricator 'A'	0.5	Minimum Gap	3		1	Mils
		Minimum Gap	3			
Duble-clicking the Data Grid row		Minimum Trace Width	3			
esents the Edit Constraints dialog		Mechanical Drill A.R.	6			
sed upon the PCB fabricators'	add or delete a constrai	Blind Via A.R.	0.5			
pabilities		Buried Via A.R.	0.5			
Highlight Set		Trace A.R.	1			Close
		< < 5 of 5 >	>>			
		Add Delete	Done Cancel			
		Instructions Add: Press Add, which will add a new 'n of n' record number will increase. I details and select Done.				
		Delete: Press Delete to remove the e 'n of n' record number will reduce. Th dialog.	xisting constraint. Notice the hen select Done to close the			
Copyright © Polar Instruments 2	024	Edit: Edit the existing constraint and dialog.	select Done to close the		pola	rinstruments



## Speedstack v23.03.01 (March 2023)



## Material Library Filter / Search Enhancements

C:\Apps\Samples\Speedstack Imperial.mlbx	— 🗆 X
🐳 🎼 📭 🗤 🗰 🕌 🏙	
	Row Filter           Image: Secret prime with the secret prime withe secret prisecret prime with the secret prime with
Foils         Prepregs         RCCs         Cores         Solder Masks         Ident Inks         Peelable Masks         Coverlays         Bond Ply         Adhesive           Supplier         Supplier         Supplier Description         Description         Pear Samples         PP/001         PrePreg 1030         Polar Samples         PP/002         PrePreg 3080         PrePreg 3080<	Flexible Cores     Shie       Stock Nu     Stock Nu       300-001     2       4.2     0.0195
*	<ul> <li>Completely new and improved filtering system implemented for the Material Library, Add Material and Swap Material options</li> <li>The filter options are now placed above the selected material Data Grid, so they are always accessible and easily editable</li> <li>The current filter settings are shared between the Material Library, Add Material and Swap Material options.</li> <li>When the Material Library, Add Material and Swap Material options are closed, the current filters are automatically reapplied when these options are next used</li> <li>Filters are also retained between Speedstack sessions</li> <li>Please Note: the previous filtering system, including the ability to Load and Save Filter files (.mlf), has now been retired. Rather than needing to use Load and Save, the current filter settings are automatically saved in order that they can be shared between the Material Library, Add Material</li> </ul>
Jick on a material row to edit it	and Swap Material options



## Material Library Filter / Search Enhancements

📒 Swap F	Foil C:\Apps\S	amples\Speedstack Ir	nperial.mlbx						×
EXIT ➡∎									
Filter Field CuThic	ckness	Operand	Criter	ia	• •	- 75	Row Filter	3 = 1.4	
S	upplier	Supplier Description		Description			Stock Number	Cu Base Thickn	ness Cost Lead Time
	olar Samples	FO/002		Copper Foil			100-002	1.4	Cop 0
									Example #1 Search for Foil materials where the Copper Thickness = 1.4 mils
4									



## Material Library Filter / Search Enhancements

🏭 Swap Cor	re C:\Apps\Samples\S	peedstack Imperial.	mlbx					×
<sup>■</sup>	]							
Filter Field BaseThic		<= •		Logic	] ]	Row Filter Base Thicknee	ss >= 5 AND BaseThic	ckness <= 10
Polar Polar Polar Polar Polar Polar Polar	ofier Supplier Samples CO/010 Samples CO/011 Samples CO/013 Samples CO/013 Samples CO/015 Samples CO/016 Samples CO/016 Samples CO/017 Samples CO/018	Description	Description FR4 Core FR4 Core			Stock Number           400-010           400-011           400-012           400-013           400-014           400-015           400-016           400-017           400-018	Dielectric Base Thic 5 5 6 6 6 8 8 8 8	Example #2         Two search criteria are specified, for Core materials where the Base Thickness >= 5 mils and Base Thickness <= 10 mils
4								

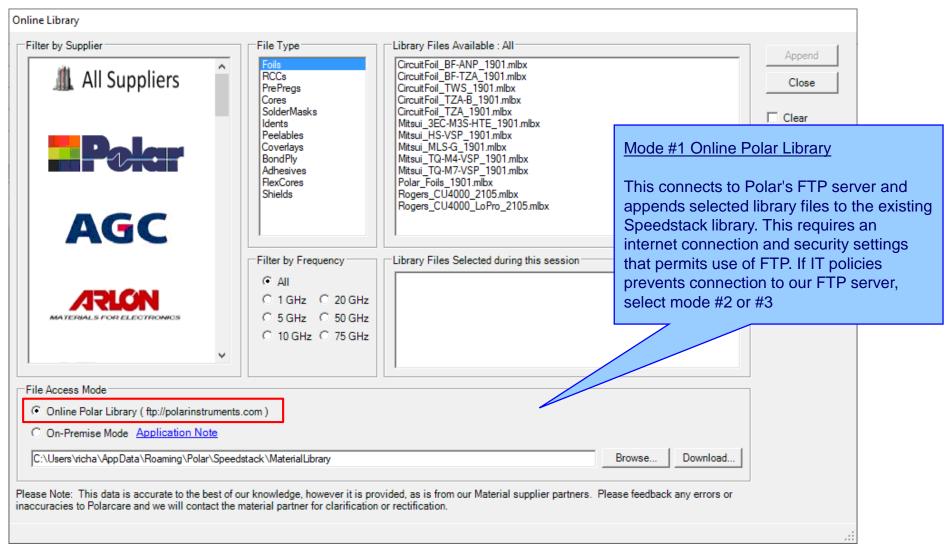


## Material Library Filter / Search Enhancements

📒 Swap Prepreg C:\Apps	\Samples\Speedstack Im	perial.mlbx					×
₩]							
Filter Field Description	Operand Like	Criteria       *80*       Image: Constraint of the second se	Logic	14	Row Filter	ike **80**	
	Supplier Description PP/001 PP/002	Description PrePreg 1080 PrePreg 3080			Stock Number 300-001 300-002	Dielectric Base This 3 3	Image: Strick and Strick
•							•

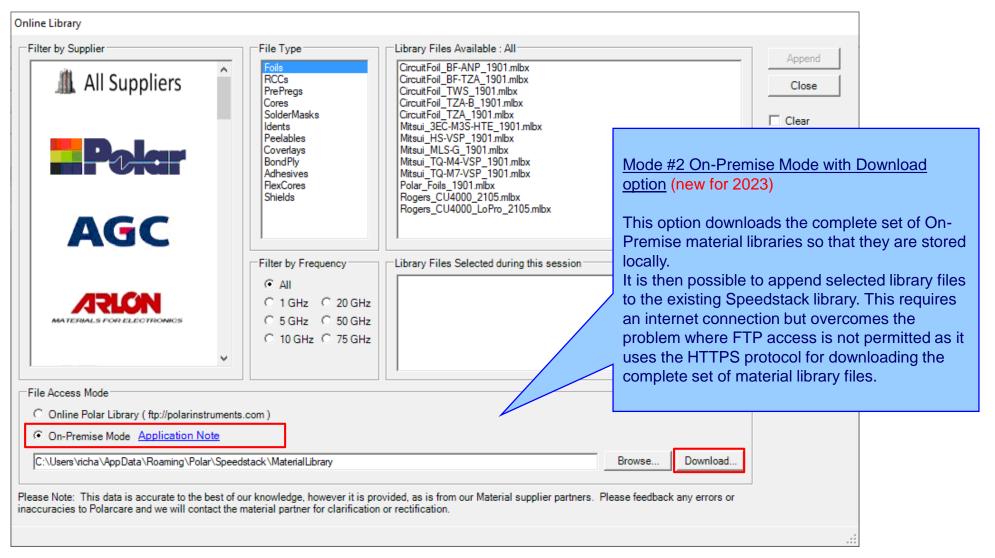


## Online Library – Now supports three modes





## Online Library – Now supports three modes





## Online Library – Now supports three modes

Online Library			
Filter by Supplier	File Type Foils RCCs PrePregs Cores SolderMasks Idents Peelables Coverlays BondPly Adhesives FlexCores Shields Filter by Frequency C All 1 GHz 20 GHz 5 GHz 50 GHz 10 GHz 75 GHz	Library Files Available : All CircuitFoil_BF-ANP_1901.mlbx CircuitFoil_BF-TZA_1901.mlbx CircuitFoil_TWS_1901.mlbx CircuitFoil_TZA-B_1901.mlbx CircuitFoil_TZA_1901.mlbx Mitsui_AS-CM3S-HTE_1901.mlbx Mitsui_MLS-G_1901.mlbx Mitsui_TQ-M4-VSP_1901.mlbx Mitsui_TQ-M4-VSP_1901.mlbx Polar_Foils_1901.mlbx Rogers_CU4000_2105.mlbx Rogers_CU4000_LoPro_2105.mlbx	Append Close Clear Mode #3 On-Premise Mode with Browse option A complete set of On-Premise material libraries are supplied as a Zip file, which can be Unzipped to a chosen folder location and then Browse to that location. It is then possible to append selected library files to the existing Speedstack library. This method is suitable where users have no internet connection so options #1 and #2 are not available. Please contact polarcare@polarinstruments.com to receive the Zip file and Unzip to a suitable
File Access Mode     Online Polar Library ( ftp://polarinstruments	.com )		folder location that is accessible by Speedstack
On-Premise Mode <u>Application Note</u> S:\Software\Speedstack\MaterialLibrary  Please Note: This data is accurate to the best of o inaccuracies to Polarcare and we will contact the r			Browse Download ease feedback any errors or



## Speedstack v22.11.01 (November 2022)



Introducing Structure View Demo File.st Project : Structure View Demo File.sci File Edit View Tools Units External Utility Help File Edit View Tools Units External Utility Help							the co structu	ntrollec ures tha 7	d impedance at exist on th D Edter   DRC : 0 Controled All 1< <	2 2	SS	
95 95 95 1.0000 1.4000 1.9500 1.9500	1 5 1 1	Displayin Farget Z Single-En ayer 1. 4. 5 Zo 1 19.54	- o : 50 nded				W1/W2 7.000 8.000		Cer ci co en polaru Substrate 1 Height Substrate 1 Dielectric	trumerts.com ◆ w1 ◆ H1 6.3500 Er1 4.2000	.↓ ↑	
95       1 4000         95       2.7760         95       5.5520         95       5.5520         95       14000         95       5.5520         95       5.5520         95       5.5520         95       5.5520         95       5.5520         95       5.5520         95       5.5520         95       5.5520         95       5.5520         95       5.5520         95       2.7760	4 4 0 5 4	19.83 19.83	14.7500 15.7500 15.7500 14.7500	99.55 99.55	9.0000 10.0000 10.0000 9.0000	12.0000 12.0000	9 0000 10 0000 10 0000 9 0000		Lower Trace Wridth Upper Trace Wridth Trace Thickness Coating Above Substrate Coating Above Trace Coating Dielectric Impedance Target Impedance Target Tolerance %	V1 10.9500 V2 9.9500 T1 1.4000 c C1 1.0000 C2 1.0000 CEr 4.0000 Zo 49.54 50.00 10.00		
The new Structure View is positioned to the right of the existing stack up. All structures are aligned with the stack up electrical layers on which they reside	7 8 4	19.54 s = 60.860	10.9500 9.9500 0	99.94 Stack Up	8.0000 7.0000 Thickness w	8.8200 ith Soldermas	8.0000 7.0000 k = 62.8600	V22.09.01	drag the the new	ss Structure V stack up to th Show / Hide S I bar button	ne left c	or use

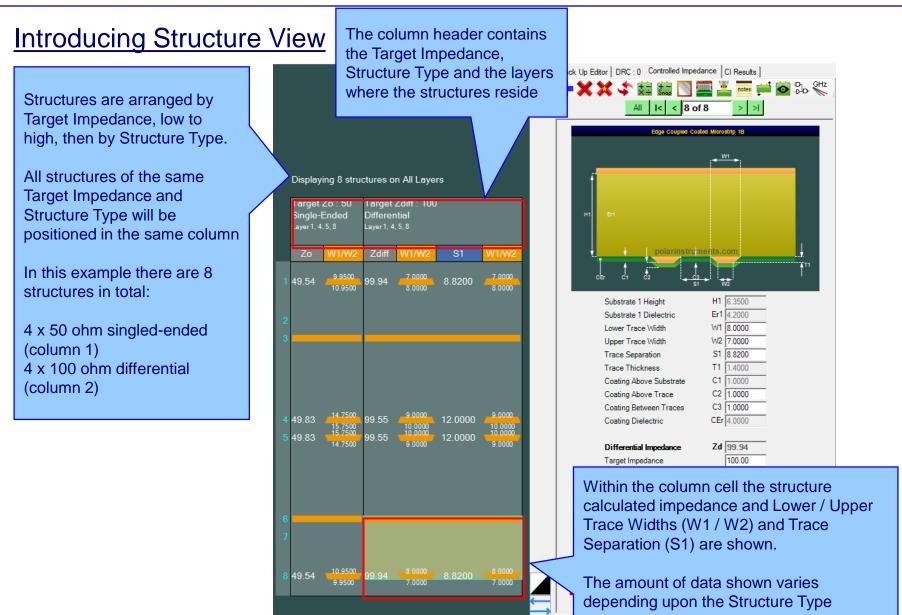
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31

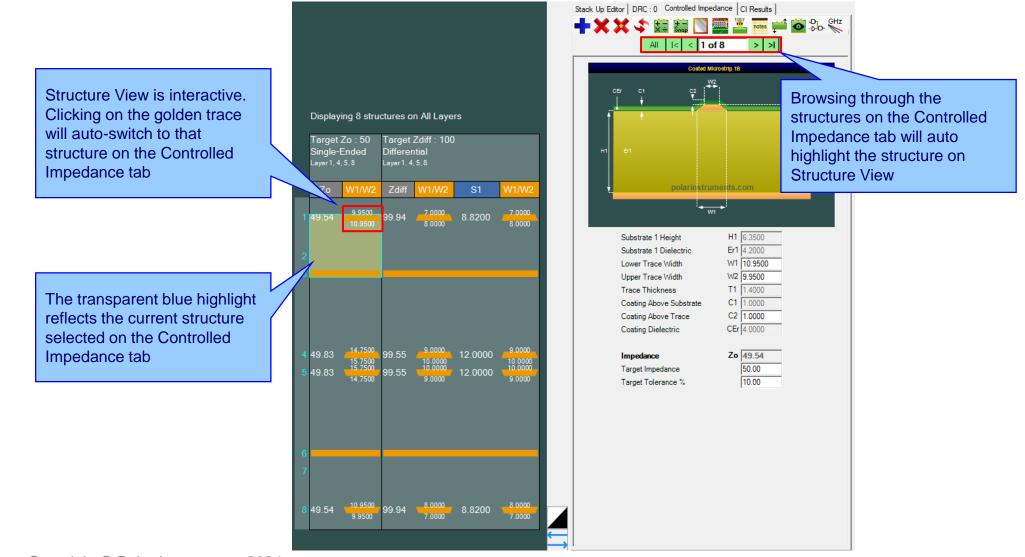
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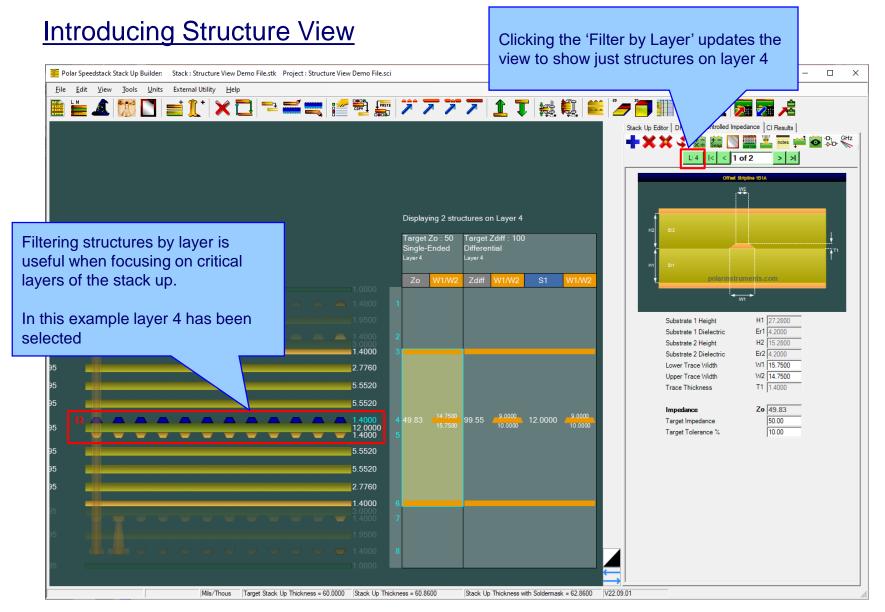


### Introducing Structure View





### Speedstack 2021 - 2024 Updates

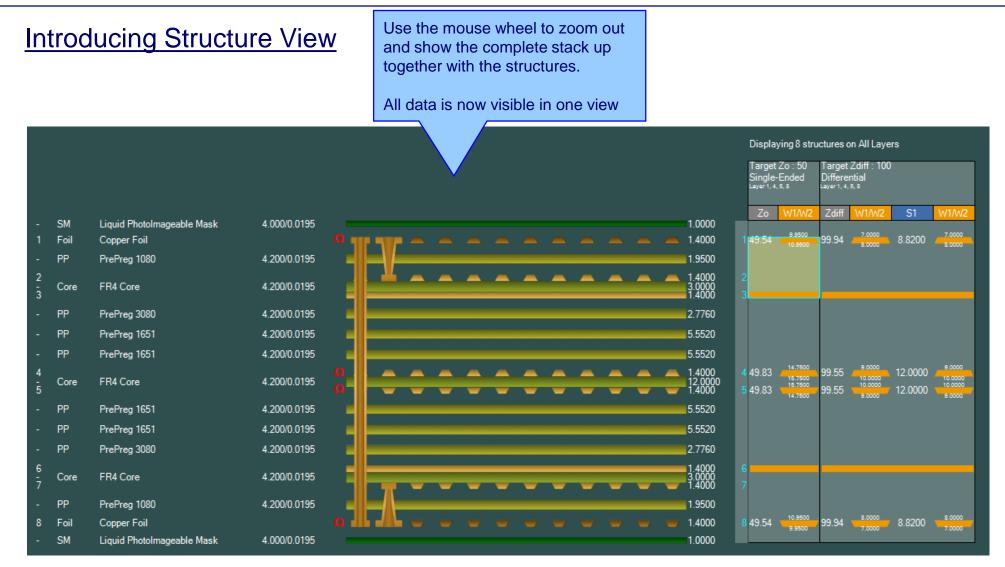


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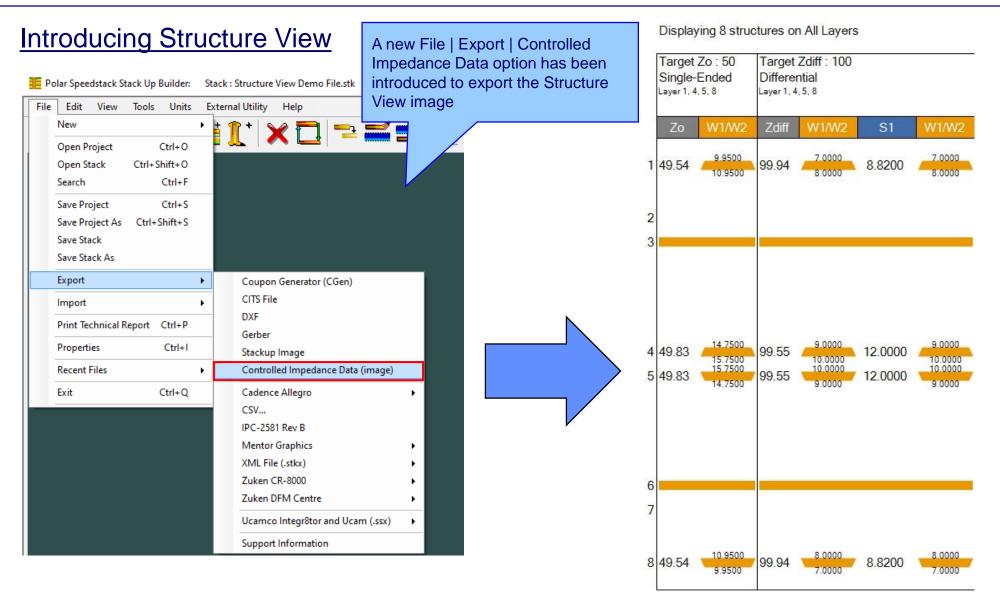
34





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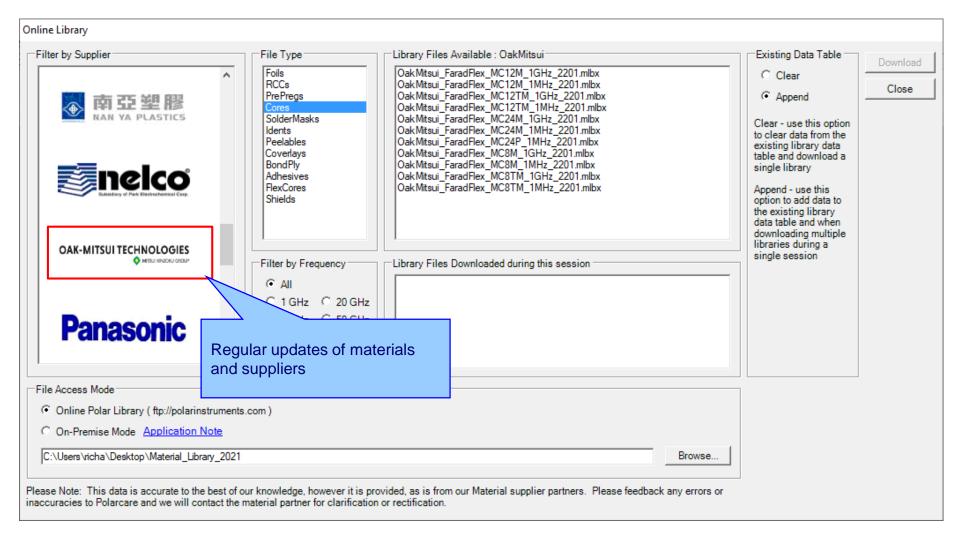


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37

## **Online Library enhancements**





# Speedstack v22.07.20 (July 2022)



# Introducing Grid View

Grid View presents the current stack up in an editable data grid form to allow for easy editing of multiple materials from a single dialog

Stack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Layer Name	Description	Processed Thickness	Dielectric Constant	Loss Tangent
0	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1.0000	4.0000	0.019
1	CSTFoil	Copper	1	Foil	Тор	Copper Foil	1.4000		
2	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.9500	4.2000	0.019
3	CSTCore	UpperCopper	2		Inner 2		1.4000		
3	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.019
3	CSTCore	LowerCopper	3		Inner 3		1.4000		
4	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.7760	4.2000	0.019
5	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.019
6	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.019
7	CSTCore	UpperCopper	4		Inner 4		1.4000		
7	CSTCore	Dielectric		Core		FR4 Core	12.0000	4.2000	0.019
7	CSTCore	LowerCopper	5		Inner 5		1.4000		
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.019
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.019
10	CSTPrePreg	Dielectric				PrePreg 3080	2.7760	4.2000	0.019
11	CSTCore	UpperCoppe			Inner 6		1.4000		
	llows for q	uick aditi	og of kov	/ stack		FR4 Core	3.0000	4.2000	0.019
			• •		Inner 7		1.4000		
	ion such as					PrePreg 1080	1.9500	4.2000	0.019
	Thickness,	Dielectri	c Consta	ant and	Bottom	Copper Foil	1.4000		
s Tange	nt.					Liquid PhotoImageable Mask	1.0000	4.0000	0.0195

/ then be edited with Excel

ent columns are editable, other colum IderMask.MaskThickness, Coverlay.

The stack up data from Grid View can also be edited in Microsoft Excel using the Grid View copy and paste functions

Changes in Grid View can be saved back to the original stack up design

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Cancel

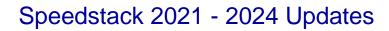
Apply



# Introducing Grid View

tack Up follection ndex	Material Class	Material Element	Electrical Layer	Mate Type	some fields are le	o preserve stack integrity – ocked.	Processed Thickness	Dielectric Constant	Loss Tangent
	CSTSolderMask	Mask		SM			1.0000	4.0000	0.0195
1	CSTFoil	Copper	1	Foil			1.4000		
2	CSTPrePreg	Dielectric		PP			1.9500	4.2000	0.0195
3	CSTCore	UpperCopper	2		miler 2		1.4000		
3	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.0195
3	CSTCore	LowerCopper	3		Inner 3		1.4000		
4	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.7760	4.2000	0.0195
5	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
6	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
7	CSTCore	UpperCopper	4		Inner 4		1.4000		
7	CSTCore	Dielectric		Core		FR4 Core	12.0000	4.2000	0.0195
7	CSTCore	LowerCopper	5		Inner 5		1.4000		
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	5.5520	4.2000	0.0195
10	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.7760	4.2000	0.0195
11	CSTCore	UpperCopper	6		Inner 6		1.4000		
11	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.0195
11	CSTCore	LowerCopper	7		Inner 7		1.4000		
12	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.9500	4.2000	0.0195
13	CSTFoil	Copper		Foil	Bottom	Copper Foil	1.4000		
						Liquid PhotoImageable Mask	1.0000	4.0000	0.0195

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							Kau information for the subole stack we can be add	te d'frame a			
View						Т.	Key information for the whole stack up can be edi	ted from a		- [	1
ick Up					1	~	single dialog / screen	1.1.4			
lection ex	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Lay	2.	If changes to the original stack up design are mad fabricator during the manufacturing stage, these of	· · · · · · · · · · · · · · · · · · ·	ctric tant	Loss Tang	ent
0	CSTSolderMask	Mask		SM			quickly evaluated by updating the Processed Thic	kness.	4.0000	0.0	)195
1	CSTFoil	Copper	1	Foil	Тор		Dielectric Constant and Loss Tangent cells. The i				
2	CSTPrePreg	Dielectric		PP			these changes on stack up thickness, controlled in	•	4.2000	0.0	)195
3	CSTCore	UpperCopper	2		Inne			· · · · · · · · · · · · · · · · · · ·			
3	CSTCore	Dielectric		Core		~	and insertion loss calculations can then be quickly		4.2000	0.0	)195
3	CSTCore	LowerCopper	3		Inne	3.		· · · · · · · · · · · · · · · · · · ·			
4	CSTPrePreg	Dielectric		PP		4.	Layer Names can be quickly assigned to electrica	I layers	4.2000	0.0	)195
5	CSTPrePreg	Dielectric		PP					4.2000	0.0	)195
6	CSTPrePreg	Dielectric		PP				5.5520	4.2000	0.0	)195
7	CSTCore	UpperCopper	4		Inner	4		1.4000			
7	CSTCore	Dielectric		Core			FR4 Core	12.0000	4.2000	0.0	)195
7	CSTCore	LowerCopper	5		Inner	5		1.4000			
8	CSTPrePreg	Dielectric		PP			PrePreg 1651	5.5520	4.2000	0.0	)195
9	CSTPrePreg	Dielectric		PP			PrePreg 1651	5.5520	4.2000	0.0	)195
10	CSTPrePreg	Dielectric		PP			PrePreg 3080	2.7760	4.2000	0.0	)195
11	CSTCore	UpperCopper	6		Inner	6		1.4000			
11	CSTCore	Dielectric		Core			FR4 Core	3.0000	4.2000	0.0	)195
11	CSTCore	LowerCopper	7		Inner	7		1.4000			
12	CSTPrePreg	Dielectric		PP			PrePreg 1080	1.9500	4.2000	0.0	)195
13	CSTFoil	Copper	8	Foil	Botto	m	Copper Foil	1.4000			
14	CSTSolderMask	Mask		SM			Liquid PhotoImageable Mask	1.0000	4.0000	0.0	)195

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41



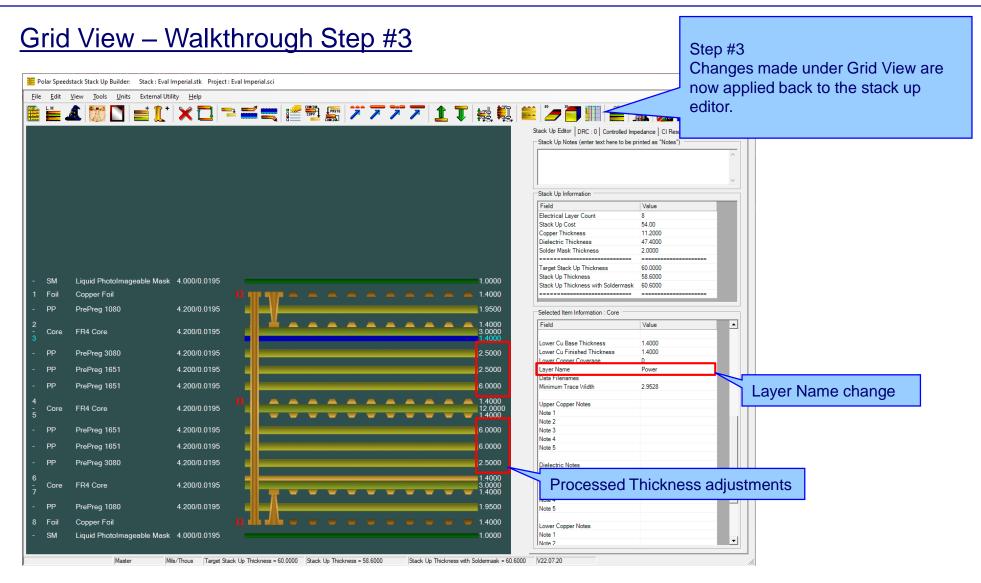




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d View							g cells are a nave been c		
itack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Layer Name	Description	ed Thicknes		
0	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1.0000	4.0000	0.019
1	CSTFoil	Copper	1	Foil	Тор	Copper Foil	1.4000		
2	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.9500	4.2000	0.019
3	CSTCore	UpperCopper	2		Inner 2		1.4000		
3	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.019
3	CSTCore	LowerCopper	3		Power		1.4000		
4	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.5000	4.2000	0.019
5	CSTPrePreg	Dielectric		PP		PrePreg 1651	2.5000	4.2000	0.019
6	CSTPrePreg	Dielectric		PP		PrePreg 1651	6.0000	4.2000	0.019
7	CSTCore	UpperCopper	4		Inner 4		1.4000		
7	CSTCore	Dielectric		Core		FR4 Core	12.0000	4.2000	0.019
7	CSTCore	LowerCopper	5		Inner 5		1.4000		
8	CSTPrePreg	Dielectric		PP		PrePreg 1651	6.0000	4.2000	0.019
9	CSTPrePreg	Dielectric		PP		PrePreg 1651	6.0000	4.2000	0.019
10	CSTPrePreg	Dielectric		PP		PrePreg 3080	2.5000	4.2000	0.019
11	CSTCore	UpperCopper	6		Ground		1.4000		
11	CSTCore	Dielectric		Core		FR4 Core	3.0000	4.2000	0.019
11	CSTCore	LowerCopper	7		Inner 7		1.4000		
12	CSTPrePreg	Dielectric		PP		PrePreg 1080	1.9500	4.2000	0.019
13	CSTFoil	Copper	8	Foil	Bottom	Copper Foil	1.4000		
14	CSTSolderMask	Mask		SM		Liquid PhotoImageable Mask	1.0000	4.0000	0.019
					ay then be edited with Exc gent columns are editable			Apply	Car







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	Stack Up Collection Index	Material Class	Material Element	Electrical Layer	Material Laye Type ID	Layer Name	Description		Processed Thickness	Dielectric Constant	Loss Tangent		
	0	CSTSolderMask	Mask		SM		Liquid PhotoImageable I	Mask	1.0000	4.0000	0.0195		
	1	CSTFoil	Copper	1	Foil	Тор	Copper Foil		1.4000				
	2	CSTPrePreg	Dielectric		PP		PrePreg 1080		1.9500	4.2000	0.0195		
	3	CSTCore	UpperCopper	2		Inner 2			1.4000				
	3	CSTCore	Dielectric		Core		FR4 Core		3.0000		0.0195	-	
	3	CSTCore CSTPrePreg	LowerCopper Dielectric	3	PP	Inner 3	PrePreg 3080		1.4000		0.0195		
- SM		CSTPrePreg	Dielectric		PP		PrePreg 1651		5.5520				
1 Foil	6	CSTPrePreg	Dielectric		PP		PrePreg 1651	Copy to Clipboard (for Excel)	5.5520			-	
- PP	7	CSTCore	UpperCopper	4		Inner 4		Paste from Clipboard (from Excel)	1.4000				
2	7	CSTCore	Dielectric		Core		FR4 Core		12.0000	4.2000	0.0195		
- Core	7	CSTCore	LowerCopper	5		Inner 5			1.4000				
Ŭ DD	8	CSTPrePreg	Dielectric		PP	1	PrePreg 1651		5.5520				
- PP	9	CSTPrePreg	Dielectric		PP		PrePreg 1651		5.5520				
- PP	10	CSTPrePreg	Dielectric		PP		PrePreg 3080		2.7760		0.0195		
- PP	11	CSTCore	UpperCopper Dielectric	6		Inner 6	FR4 Core		1.4000		0.0195		
4	11	CSTCore CSTCore	LowerC			Inner 7	FR4 Core		1.4000		0.0195		
- Core	10	COTO-De-		4	00		PrePreg 1080		1.4000		0.0195		
						Bottom	Copper Foil		1.4000				
	/ Doct	o ontic		ow fo	r tho		Liquid PhotoImageable I	Mask	1.0000	4.0000	0.0195		
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1 Stack U	p Collection Index Material Class	Material Element	Electrical Layer M	aterial Layer Type	ID Layer Nam	e Description	Processed Thickness Diele	ctric Constant Loss T	angent					
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3	1 CSTFoil	Copper	1 Fc	bil	Тор	Copper Foil	1.4							
4	2 CSTPrePreg	Dielectric	PF	<b>)</b>		PrePreg 1080	1.95	4.2	0.0195					
5	3 CSTCore	UpperCopper	2		Inner 2		1.4							
6	3 CSTCore	Dielectric	Co	ore		FR4 Core	3	4.2	0.0195					
7	3 CSTCore	LowerCopper	3		Inner 3		1.4							
8	4 CSTPrePreg	Dielectric	PF	>		PrePreg 3080	2.776	4.2	0.0195					
9	5 CSTPrePreg	Dielectric	PF	<b>)</b>		PrePreg 1651	5.552	4.2	0.0195					
10	6 CSTPrePreg	Dielectric	PF	<b>b</b>		PrePreg 1651	5.552	4.2	0.0195					
11	7 CSTCore	UpperCopper	4		Inner 4		1.4							
12	7 CSTCore	Dielectric	Co	ore		FR4 Core	12	4.2	0.0195					
13	7 CSTCore	LowerCopper	5		Inner 5		1.4							
14	8 CSTPrePreg	Dielectric	PF	<b>)</b>		PrePreg 1651	5.552	4.2	0.0195					
15	9 CSTPrePreg	Dielectric	PF	<b>)</b>		PrePreg 1651	5.552	4.2	0.0195					
16	10 CSTPrePreg	Dielectric	PF	<b>)</b>		PrePreg 3080	2.776	4.2	0.0195					
17	11 CSTCore	UpperCopper	6		Inner 6		1.4							
18	11 CSTCore	Dielectric	Co	ore		FR4 Core	3	4.2	0.0195					
19	11 CSTCore	LowerCopper	7		Inner 7		1.4							
20	12 CSTPrePreg	Dielectric	PF	<b>b</b>		PrePreg 1080	1.95	4.2	0.0195					
21	13 CSTFoil	Copper	8 Fc	bil	Bottom	Copper Foil	1.4							
22	14 CSTSolderMask	Mask	SM	Λ		Liquid PhotoImageable Mask	1	4	0.0195					
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1 Stack Up Collection Inc	ex Material Class	Material Ele	ment Electrical L	ayer Materia	l Layer Type ID	Layer Nam	e Description	Processed Thickness	Dielectric Constant	Loss Tangent							
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3	1 CSTFoil	Copper		1 Foil		Тор	Copper Foil	1.5									
4	2 CSTPrePreg	Dielectric		PP			PrePreg 1080	2.1	4.2	0.0195							
5	3 CSTCore	UpperCopp	er	2		Inner 2		1.4								_	
6	3 CSTCore	Dielectric		Core			FR4 Core	3	4.2	0.0195						_	
7	3 CSTCore	LowerCopp	er	3		Inner 3		1.4								_	
8	4 CSTPrePreg	Dielectric		PP PP			PrePreg 3080	2.776	4.2	0.0195						-	
10	5 CSTPrePreg	Dielectric Dielectric		PP			PrePreg 1651	5.552	4.2	0.0195						-	
11	6 CSTPrePreg 7 CSTCore	UpperCopp	or	4		Inner 4	PrePreg 1651	5.552	4.2	0.0195						-	
12	7 CSTCore	Dielectric	ei	4 Core		liller 4	FR4 Core	1.4	4.2	0.0195						-	
13	7 CSTCore	LowerCopp	er	5		Inner 5	The core	1.4	4.2	0.0155						-	
14	8 CSTPrePreg	Dielectric		PP			PrePreg 1651	5.552	4.2	0.0195						-	
15	9 CSTPrePreg	Dielectric		PP			PrePreg 1651	5.552	4.2	0.0195						-	
16	10 CSTPrePreg	Dielectric		PP			PrePreg 3080	2.776	4.2	0.0195							
17	11 CSTCore	UpperCopp	er	6		Inner 6	_	1.4									
18	11 CSTCore	Dielectric		Core			FR4 Core	3	4.2	0.0195							
19	11 CSTCore	LowerCopp	er	7		Inner 7		1.4									
20	12 CSTPrePreg	Dielectric		PP			PrePreg 1080	2.1	4.2	0.0195						_	
21	13 CSTFoil	Copper		8 Foil		Bottom	Copper Foil	1.5								_	
22	14 CSTSolderMask	Mask		SM			Liquid PhotoImageable Mask	1	4	0.0195						-	
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# <u>Using Grid View with Microsoft Excel – Step #4</u>

Step #4 Once the Excel changes are complete select the range of cells representing the whole stack up data and select

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A In Collection Index	B Astorial Class	C Matarial Flament	D E Electrical Layer Material Layer Type	F Lawer Name		H Processed Thickness Diele	tric Constant Lo	J	К	L	М	N	0
	STSolderMask		SM	e ID Layer Name	Liquid PhotoImageable Mask	Processed Inickness Diele	4	0.0195					
		Copper	1 Foil	Тор	Copper Foil	1.5	4	0.0155					
		Dielectric	PP	TOP	PrePreg 1080	2.1	4.2	0.0195					
		UpperCopper	2	Inner 2		1.4		0.0150					
		Dielectric	Core		FR4 Core	3	4.2	0.0195					
		LowerCopper	3	Inner 3		1.4							
		Dielectric	PP		PrePreg 3080	2.776	4.2	0.0195					
		Dielectric	PP		PrePreg 1651	5.552	4.2	0.0195					
		Dielectric	PP		PrePreg 1651	5.552	4.2	0.0195					
7 0	STCore	UpperCopper	4	Inner 4		1.4							
7 0	STCore	Dielectric	Core		FR4 Core	10	4.2	0.0195					
7 0	STCore	LowerCopper	5	Inner 5		1.4							
8 C	STPrePreg	Dielectric	PP		PrePreg 1651	5.552	4.2	0.0195					
9 0	STPrePreg	Dielectric	PP		PrePreg 1651	5.552	4.2	0.0195					
10 0	STPrePreg	Dielectric	PP		PrePreg 3080	2.776	4.2	0.0195					
11 0	STCore	UpperCopper	6	Inner 6		1.4							
11 0	STCore	Dielectric	Core		FR4 Core	3	4.2	0.0195					
11 0	STCore	LowerCopper	7	Inner 7		1.4							
12 0	STPrePreg	Dielectric	PP		PrePreg 1080	2.1	4.2	0.0195					
13 C	STFoil	Copper	8 Foil	Bottom	Copper Foil	1.5							
14 C	STSolderMask	Mask	SM		Liquid PhotoImageable Mask	1	4	0.0195					

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48

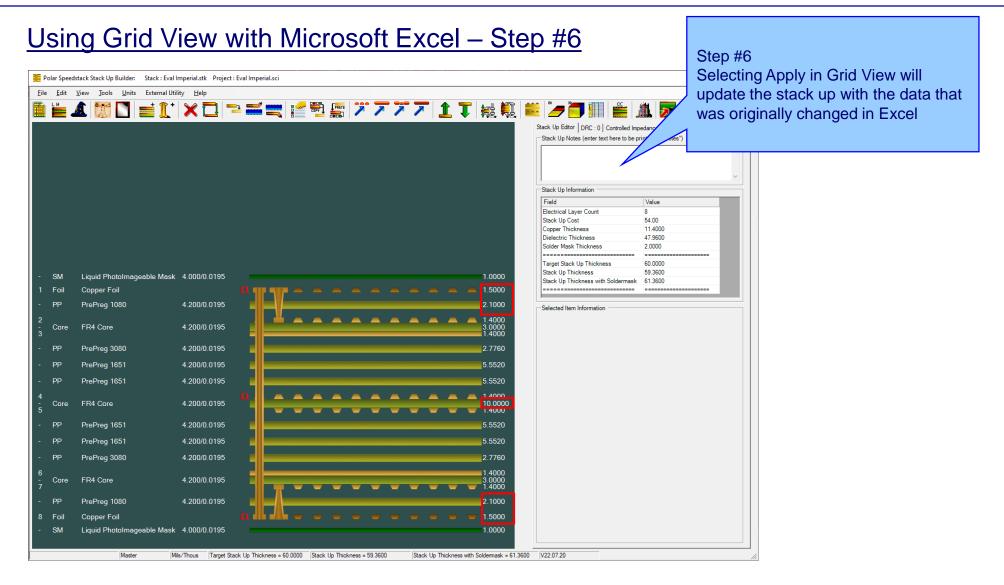


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View								menu Pas			
ack Up ollection dex	Material Class	Material Element	Electrical Layer	Material Layer Type ID	Layer Name		Description	data from now matc		otice how	the da
0	CSTSolderMask	Mask		SM			Liquid PhotoImageable Mask		1.0000	4.0000	0.0195
1	CSTFoil	Copper	1	Foil	Тор		Copper Foil		1.5000		
2	CSTPrePreg	Dielectric		PP			PrePreg 1080		2.1000	4.2000	0.0195
3	CSTCore	UpperCopper	2		Inner 2				1.4000		
3	CSTCore	Dielectric		Core			FR4 Core		3.0000	4.2000	0.0195
3	CSTCore	LowerCopper	3		Inner 3				1.4000		
4	CSTPrePreg	Dielectric		PP			PrePreg 3080		2.7760	4.2000	0.0195
5	CSTPrePreg	Dielectric		PP		Convito Cl	ipboard (for Excel)		5.5520	4.2000	0.0195
6	CSTPrePreg	Dielectric		PP			Clipboard (from Excel)		5.5520	4.2000	0.0195
7	CSTCore	UpperCopper	4		Inner 4	Paste from	Cipboard (irom Excel)		1.4000		
7	CSTCore	Dielectric		Core			FR4 Core		10.0000	4.2000	0.0195
7	CSTCore	LowerCopper	5		Inner 5				1.4000		
8	CSTPrePreg	Dielectric		PP			PrePreg 1651		5.5520	4.2000	0.0195
9	CSTPrePreg	Dielectric		PP			PrePreg 1651		5.5520	4.2000	0.0195
10	CSTPrePreg	Dielectric		PP			PrePreg 3080		2.7760	4.2000	0.0195
11	CSTCore	UpperCopper	6		Inner 6				1.4000		
11	CSTCore	Dielectric		Core			FR4 Core		3.0000	4.2000	0.0195
11	CSTCore	LowerCopper	7		Inner 7				1.4000		
12	CSTPrePreg	Dielectric		PP			PrePreg 1080		2.1000	4.2000	0.0195
13	CSTFoil	Copper	8	Foil	Bottom		Copper Foil		1.5000		
14	CSTSolderMask	Mask		SM			Liquid Photolmageable Mask		1.0000	4.0000	0.0195

Processed Thickness = Copper.FinishedThickness, Dielectric.IsolationDistance, SolderMask.MaskThickness, Coverlay.FinishedThickness







## Other enhancements

- Stack Up Notes user interface improvements
- The Tools | Options | Structure Defaults | Separation Region Dielectric (REr) now supports double data types. Previously, it only supported integers

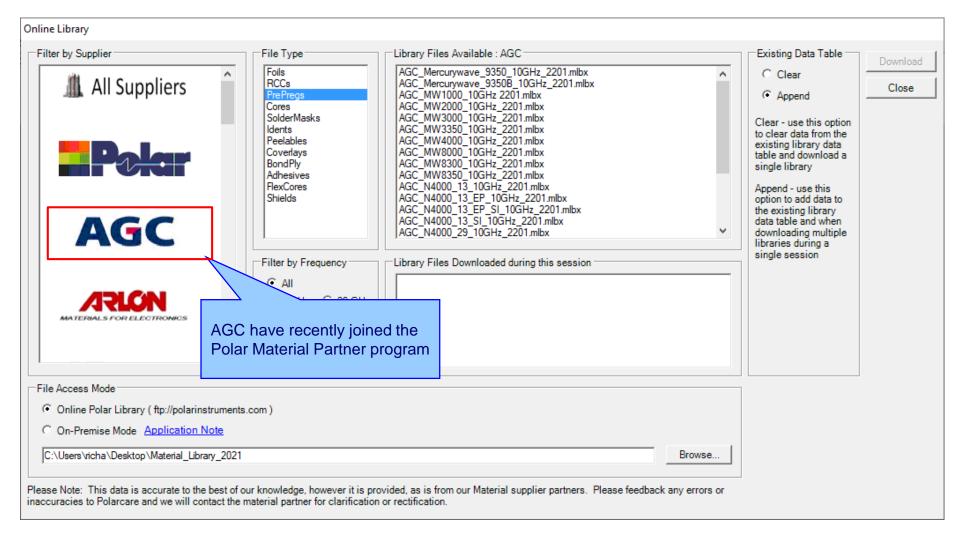


# Speedstack v22.05.06 (May 2022)



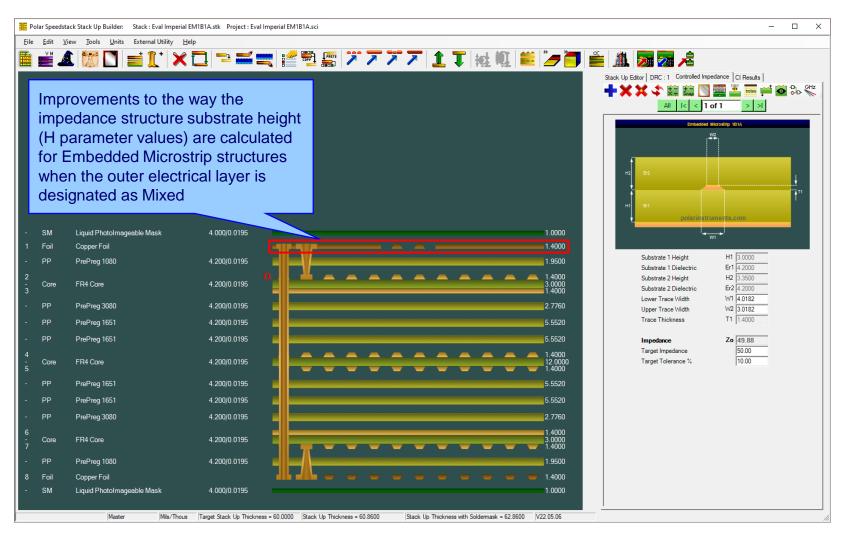
53

## **Online Library enhancements**



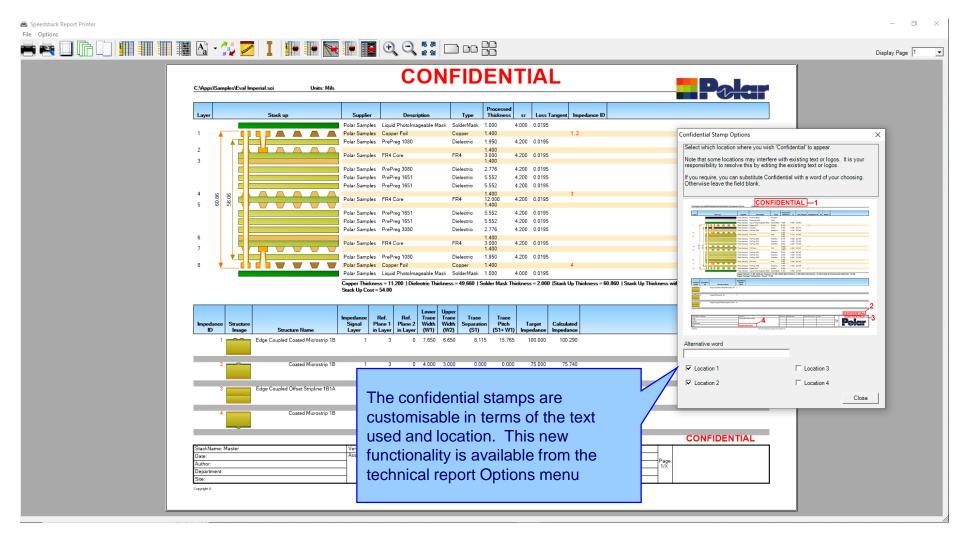


## Embedded Microstrip structure enhancements





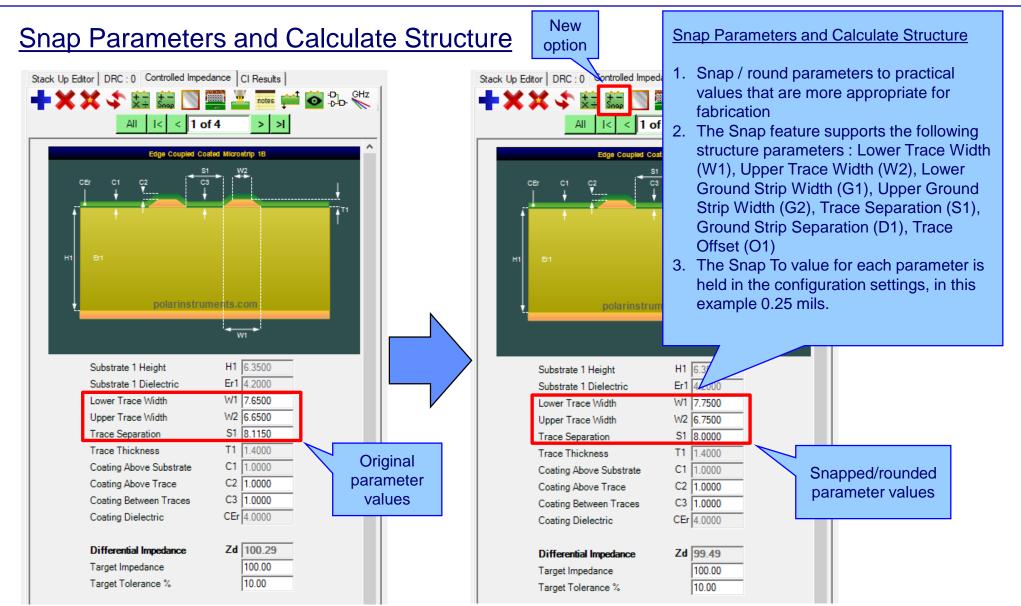
## New Confidential Stamp options added to the technical report





# Speedstack v22.01.01 (January 2022)





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## **Snap Parameters and Calculate Structure**

Configuration Options				×
External Utilities Rebuild and Calculate S General Structure Defaults Licensing		Goal Seeking	User	er CITS Test Colours Miscellaneous Hatch Defaults
Structures Lower Trace Width (W1) Upper Trace Width (W2) Lower Ground Strip Width (G1) Upper Ground Strip Width (G2) Trace Separation (S1) Ground Strip Separation (D1)	Default 10.0000 9.0000 100.0000 99.0000 10.0000 10.0000	Snap To 0.2500 0.2500 0.2500 0.2500 0.2500 0.2500		Board Thickness Board Thickness Plus % 10 Minus % 10 Drilling Minimum Hole Size 20.0000
Trace Offset (O1) Separation Region Dielectric (REr)	0.0000	0.2500		The Snap To value for each parameter is he in the configuration settings, accessible from the Tools   Options   Structure Defaults tab. Although all Snap To values shown here are set to 0.25 mils, each parameter can suppor a different value



## Material Library Enhancements

		<b>1</b> 4 <b>1</b> 4 <b>1</b>		🖌 🗀 🛝					
ils	Prepregs RCCs	Cores   Solder Masks	Ident Inks   Peelable Masks   Coverlays   Bond Ply   Adh	esive   Flexible Cores   Shields					
	Supplier	Supplier Description	Description	Stock Number	Dielectric Base Thickness	Dielectric Finished Thickness	Tolerance	Dielectric Constant	Loss Tangent
	Polar Samples	PP/001	PrePreg 1080	300-001	3	3	0	4.2	0.0195
	PolarSamples	PP/002	PrePreg 3080	300-002	3	3	0	4.2	0.0195
	Polar Samples	PP/003	PrePreg 3113	300-003	4	4	10	4.2	0.0195
	Polar Samples	PP/004	PrePreg 1651	300-004	6	6	10	4.2	0.0195
	PolarSamples	PP/005	PrePreg 7628	300-005	7.9	7.9	10	4.2	0.0195
_	PolarSamples	PP/006	PrePreg 106	300-006	2	2	10	4.2	0.0195
							materia tolerand Previou would p	ls with a die ce of 0%. s versions o	y now support electric thickne of Speedstack iser to enter a 0%

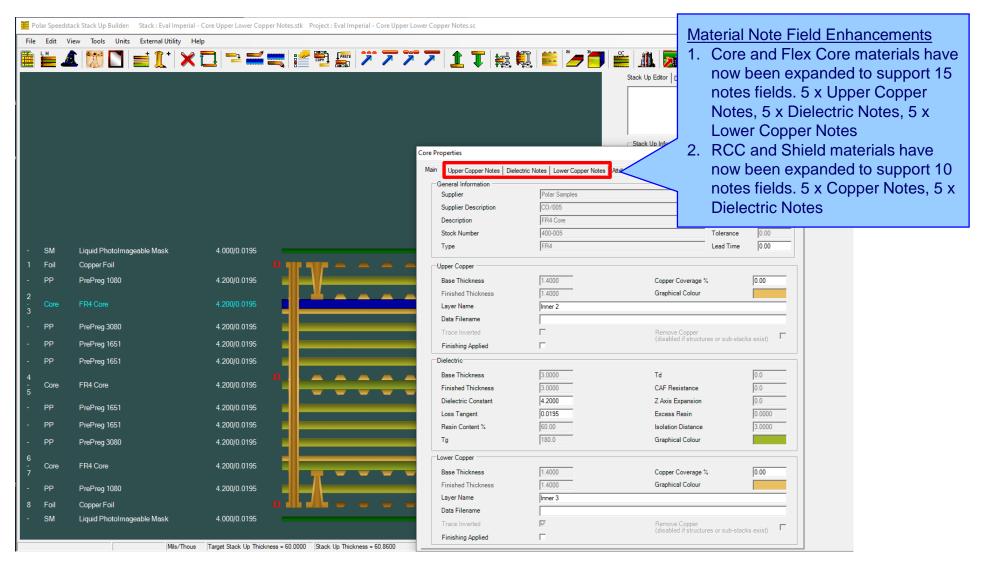


# Speedstack v21.11.01 (November 2021)



61

## Material Note Field Enhancements – improvements to stack up documentation





## <u>Material Note Field Enhancements – improvements to stack up documentation</u>

Core Properties Main Upper Copper 1 Notes	Notes Dielectric Notes Lower Copper Notes Attributes Apply	The new Upper and Lower Copper Notes allow the user to specify
Note 1 Note 2 Note 3	Roughness: Very-low profile (VLP)	important information about the copper surfaces for a Core and Flex Core material.
Note 4 Note 5		For instance, copper roughness and plating fabrication information can be
		specified

62



## <u>Material Note Field Enhancements – improvements to stack up documentation</u>

Notes Note 1	Notes Dielectric Notes Lower Copper Notes Attributes Attributes	Dielectric Notes are useful for specifying IPC-4101 slash sheet categories, glass weave information (spread glass) and other important
Note 2 Note 3		information regarding the dielectric region of the core.
Note 4 Note 5		The existing five Notes fields from previous versions of Speedstack will be allocated as Dielectric Notes.

63



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## Material Note Field Enhancements – improvements to stack up documentation

-Selected Item Information : Core

<b>A A A</b> 1.4000
1.9500
1.4000 3.0000 1.4000
2.7760
5.5520
5.5520
1.4000 12.0000 1.4000
5.5520
5.5520
2.7760
1.4000 3.0000 1.4000
1.9500
<b>— — — —</b> 1.4000
1.0000
ess with Soldermask = 62.8600 V21.11.01

Field	Value
Upper Copper Notes	
Note 1	Roughness: Very-low profile
Note 2	
Note 3	
Note 4	
Note 5	
Dielectric Notes	
Note 1	IPC-4101 /21 /24 /26
Note 2	
Note 3	
Note 4	
Note 5	
Lower Copper Notes	
Note 1	Roughness: Very-low profile
Note 2	
Note 3	
Note 4	
Note 5	
Cost	5
Lead Time	0
Attributes	

When selecting a core / flex core material the Upper Copper, Dielectric and Lower Copper Notes can be confirmed here.

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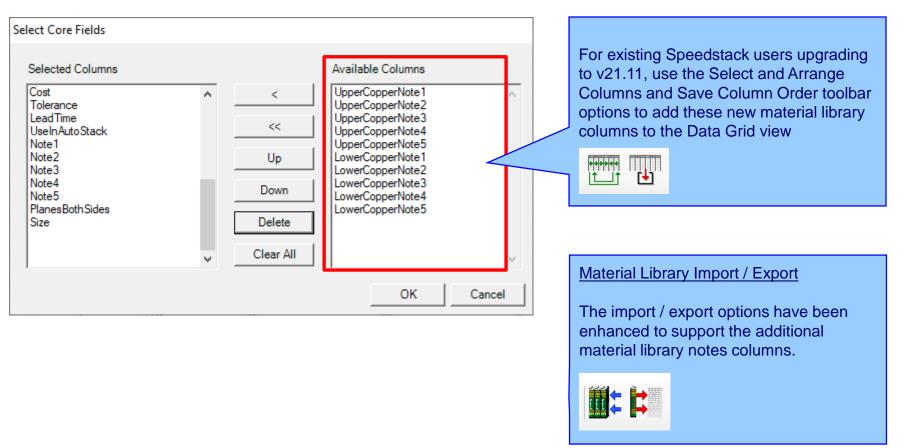


## <u>Material Note Field Enhancements – library enhancements</u>

Review/Edit Cores							
Supplier	Polar Samples	Upper Copper No	otes	Dielectric Notes		Lower Copper Notes	
Supplier Description	CO/005	Note 1	Roughness: Very-low profile (VLP)	Note 1	IPC-4101 /21 /24 /26	Note 1	Roughness: Very-low profile (VLP)
Description	FR4 Core						
Stock Number	400-005						
Туре	FR4	Note 2		Note 2		Note 2	
Base Thickness	3.0000						
Finished Thickness	3.0000						
Dielectric Constant	4.2	Note 3		Note 3		Note 3	
Loss Tangent	0.0195						
Resin Content	60						
Tg	180	Note 4		Note 4		Note 4	
ſd	0						
AF Resistance	0						
Axis Expansion	0	Note 5	1	Note 5		Note 5	
Tolerance +/-%	10	Note 5		Note 5		Note 5	
Upper Cu Thickness	1.4000	-					
Lower Cu Thickness	1.4000						
Cost	5						
Lead Time	0					<b></b>	
Size	•	_		The Speedsta	ick material library ha		
Jse in Auto Stack	, ,					-	ed to support the ext
Planes Both Sides						notes fields.	
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							to the materials in the
						library will aut	omatically be
						transferred to	the stack up.

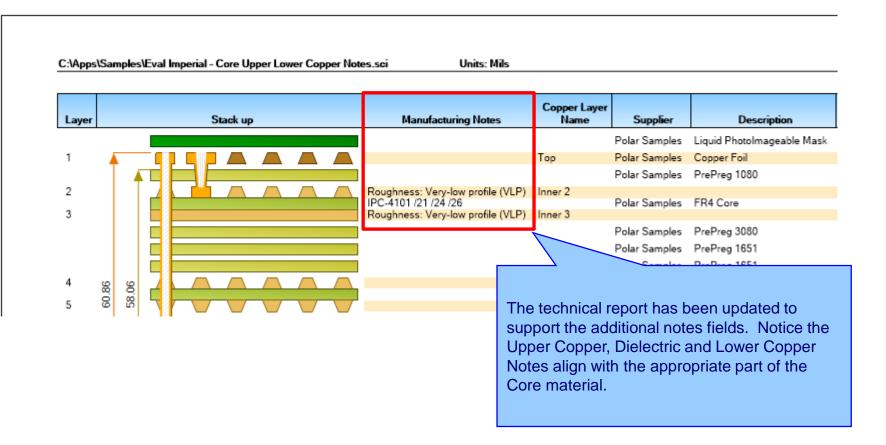


## Material Note Field Enhancements – library enhancements





### Material Note Field Enhancements – technical report enhancements





## Import / Export enhancements

The following Import / Export options have been updated to support the additional material notes properties introduced with Speedstack v21.11.01:

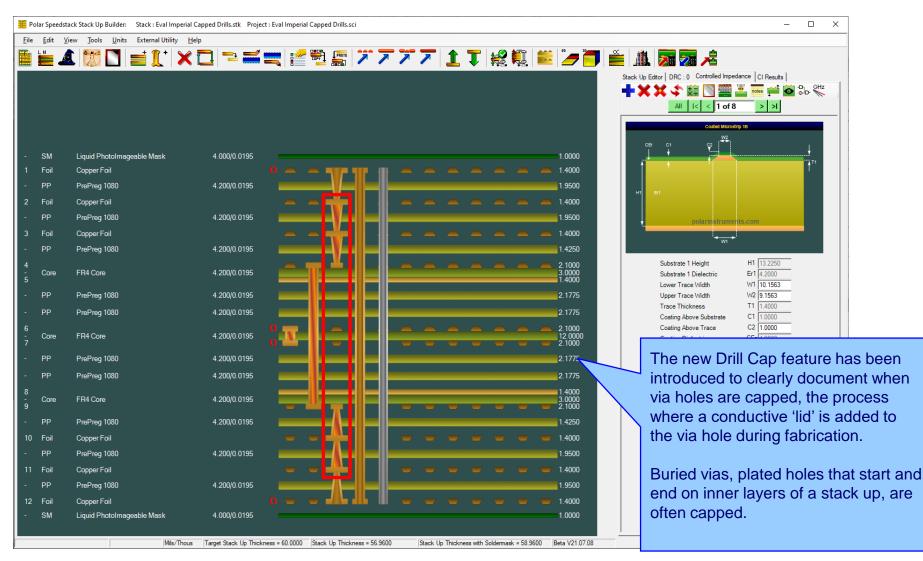
- XML STKX v23.00 and SSX v13.00 import / export options
- CSV export option



# Speedstack v21.07.08 (July 2021)



## New Drill Cap feature





# Drill Cap option – mechanical through plated drills

Drill Properties		×	
Main     Notes       Electrical Layers     First Electrical Layer       Stack Up Column     First Electrical Layer       2     ✓       4     ✓		Cut Back Drill Must-Not-Cut Layer No	<u>Mechanical</u> For mechanical drills it is possible to have four states: 1.Neither first or second layer capped (default when adding a drill)
Drill Information <ul> <li>Mechanical</li> <li>Fill Type</li> <li>Laser</li> <li>Copper Paste</li> <li>Back Drill</li> </ul> <ul> <li>Through Plated</li> <li>First Layer Capped</li> <li>Second Layer Capped</li> <li>Data Filenames</li> </ul>	Hole Information Hole Count 0 Different Hole Sizes 0 Minimum Hole Size 0.0000 Minimum Pad Size 0.0000	Minimum Drill Size 0.0000 Minimum Drill Size Tolerance (Abs) 0.0000 Minimum Barrel Wall Thickness 0.0000	<ul><li>2.First layer capped</li><li>3.Second layer capped</li><li>4.Both layers capped</li></ul>
Back Drill Information         Minimum Distance From         Must-Cut Layer         0.0000         Maximum Distance From         Must-Cut Layer         0.0000         Maximum Distance From         Must-Cut Layer         0.0000         Primary Drill Size         0.0000		Apply Cancel	

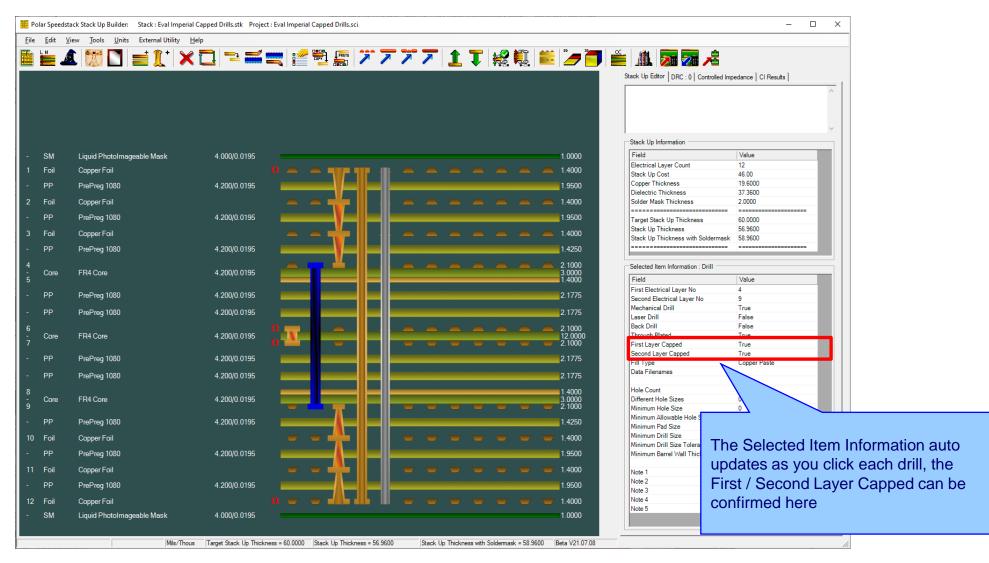


# Drill Cap option – laser drills

Drill Properties		;	<	
Main Notes Electrical Layers Stack Up Column First Electrical Layer Second Ele No (Start Layer) Layer No (I 3		-Cut Back Drill Must-Not-Cut Layer No		Laser For laser drills it is possible to have two states as the Second Layer Capped checkbox is disabled: 1.Not capped (default when adding a
Drill Information         C Mechanical       Fill Type         Laser       Copper Paste         Back Drill         Through Plated       First Layer Capped         Data Filenames	Hole Information Hole Count 0 Different Hole Sizes 0 Minimum Hole Size 0.0000 Minimum Pad Size 0.0000	Minimum Drill Size 0.0000 Minimum Drill Size Tolerance (Abs) 0.0000 Minimum Barrel Wall Thickness 0.0000		drill) 2.First layer capped
Back Drill Information         Minimum Distance From         Must-Cut Layer         0.0000         Maximum Distance From         Must-Cut Layer         0.0000         Maximum Distance From         Must-Cut Layer         0.0000         Maximum Distance From         Must-Cut Layer         0.0000         Primary Drill Size         0.0000		Apply Cancel		



### New Drill Cap feature





### <u>New Drill Cap feature – technical report enhancements</u>

	es\Eval Imperial Capped	Drille eci U	nits: Mils									
			III.3. IVIII.3									
Layer	Stack up	р	Copper Layer Name	Supplier	Descrip	otion	Турө	Processed Thickness	ъr	Loss Tangent	Impedance ID	
				Polar Samples	Liquid Photolmag	jeable Mask	SolderMask	1.000	4.000	0.0195		
1 🔺			Тор	Polar Samples	Copper Foil		Copper	1.400			1, 2	
				Polar Samples	PrePreg 1080		Dielectric	1.950	4.200	0.0195		
2			Inner 2	Polar Samples	Copper Foil		Copper	1.400				
				Polar Samples	PrePreg 1080		Dielectric	1.950	4.200	0.0195		
3			Inner 3	Polar Samples	Copper Foil		Copper	1.400				
				Polar Samples	PrePreg 1080		Dielectric	1.425	4.200	0.0195		
4			Inner 4	Polar Samples	EP4 Core		FR4	2.100 3.000	4 200	0.0195		
5			Inner 5	Polar Samples	FR4 COIB		FN4	1.400	4.200	0.0195		
				Polar Samples	PrePreg 1080		Dielectric	2.178	4.200	0.0195		
				Polar Samples	PrePreg 1080		Dielectric	2.178	4.200	0.0195		
6 96 9			Inner 6					2.100			3, 4	
2 26.9			Inner 7	Polar Samples	FR4 Core		FR4	12.000 2.100	4.200	0.0195	5, 6	
,				Polar Samples	PrePreg 1080		Dielectric	2.178	4 200	0.0195	0,0	
				Polar Samples	-		Dielectric	2.178		0.0195		
8			Inner 8					1.400				
0			Inner O	Polar Samples	FR4 Core		FR4	3.000	4.200	0.0195		
9			Inner 9	Delar Sampler	DroDrog 1090		Dielectric	2.100 1.425	4 200	0.0195		
10			Inner 10	Polar Samples				1.425	4.200	0.0195		
10			IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII	Polar Samples Polar Samples			Copper Dielectric	1.400	4 200	0.0195		
11			Inner 11	Polar Samples	2		Copper	1.400	4.200	0.0190		
				Polar Samples			Dielectric	1.950	4 200	0.0195		
12			Bottom	Polar Samples Polar Samples	-		Copper	1.400	4.200		7, 8	
			ottom	Folar Samples	Сорры Рол		SolderMask			0.0195	7,0	



### Import / Export enhancements

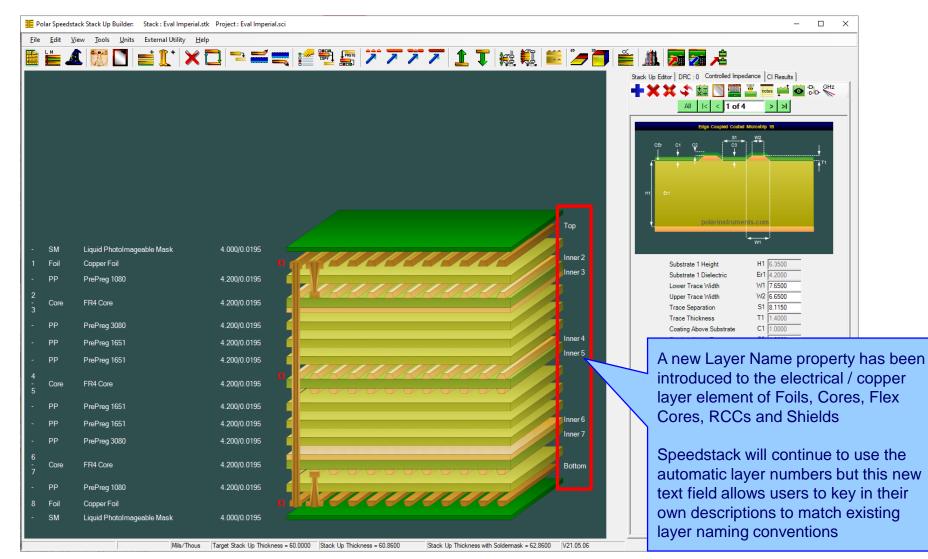
The following Import / Export options have been updated to support the drill cap properties introduced with Speedstack v21.07.08:

- XML STKX v22.00 and SSX v12.00 import / export options
- CSV export option



# Speedstack v21.05.06 (May 2021)







Foil P	roperties					
Mai	n Notes Attributes					
Г	General Information					Apply
	Supplier	Polar Samples				
	Supplier Description	FO/001				Foil Properties
	Description	Copper Foil		Cost	1.00	The new Layer Name property exists
	Stock Number	100-001				on all materials with an electrical /
	Туре	Copper		Lead Time	0.00	copper layer. The user can key in any
	Copper					alphanumeric name
	Base Thickness	0.7000	Copper Coverage %	6	0.00	
	Finished Thickness	1.4000	Graphical Colour			
	Layer Name	Тор				
	Data Filename					
	Trace Inverted		Remove Copper (disabled if structur	an ar aub ataal	(a aviat)	r I I
	Finishing Applied		(disabled il structur	es or sub-stact	(s exist)	

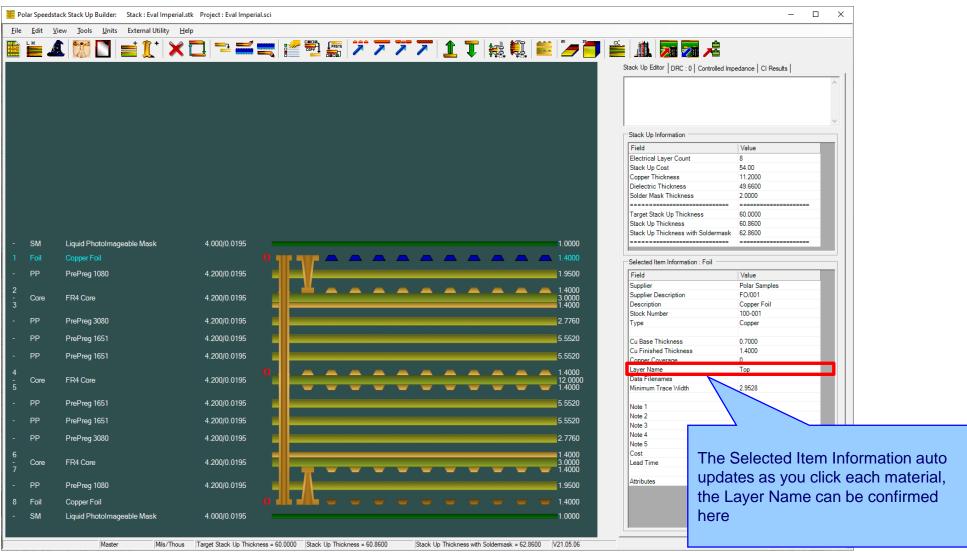


ore Properties					7
Main Notes Attributes					
General Information				Apply	
Supplier	Polar Samples		Exchange Copper	Close	
Supplier Description	CO/005				
Description	FR4 Core		Cost 5.00		
Stock Number	400-005		Tolerance 0.00		Core Properties
Туре	FR4		Lead Time 0.00		
Upper Copper					For core materials, a new Layer Name
Base Thickness	1.4000	Copper Coverage %	6 0.00		property has been added for both
Finished Thickness	1.4000	Graphical Colour			upper and lower electrical / copper
Layer Name	Inner 2				layers
Data Filename					
Trace Inverted		Remove Copper	res or sub-stacks exist)		
Finishing Applied	Γ	(disabled if structur	res or sub-stacks exist)		
Dielectric					
Base Thickness	3.0000	Td	0.0		
Finished Thickness	3.0000	CAF Resistance	0.0		
Dielectric Constant	4.2000	Z Axis Expansion	0.0		
Loss Tangent	0.0195	Excess Resin	0.0000		
Resin Content %	60.00	Isolation Distance	3.0000		
Tg	180.0	Graphical Colour			
Lower Copper					
Base Thickness	1.4000	Copper Coverage %	6 0.00		
Finished Thickness	1.4000	Graphical Colour			
Layer Name	Inner 3				
Data Filename					
Trace Inverted	$\overline{\checkmark}$	Remove Copper (disabled if structure	res or sub-stacks exist)		
Finishing Applied		(disabled if structur	sa or add addita cyraty		

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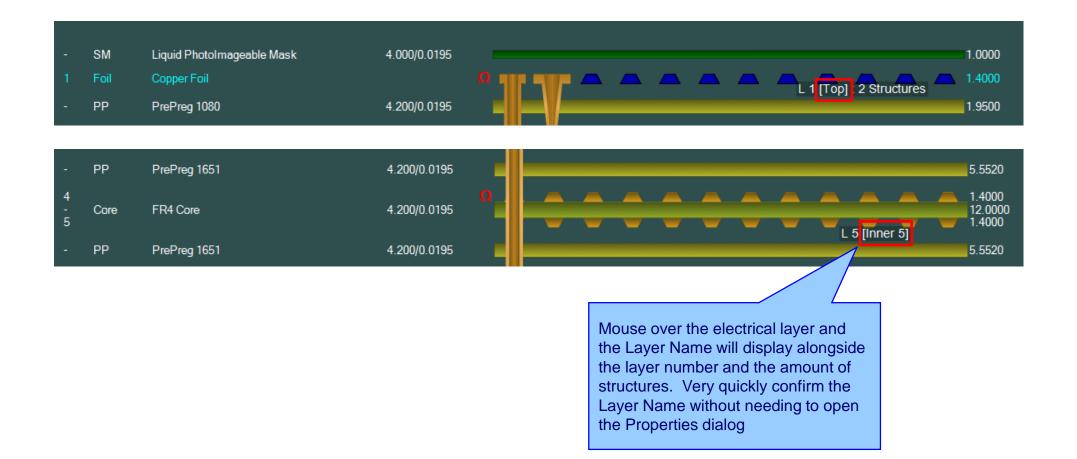


### New Layer Name property for electrical / copper layers



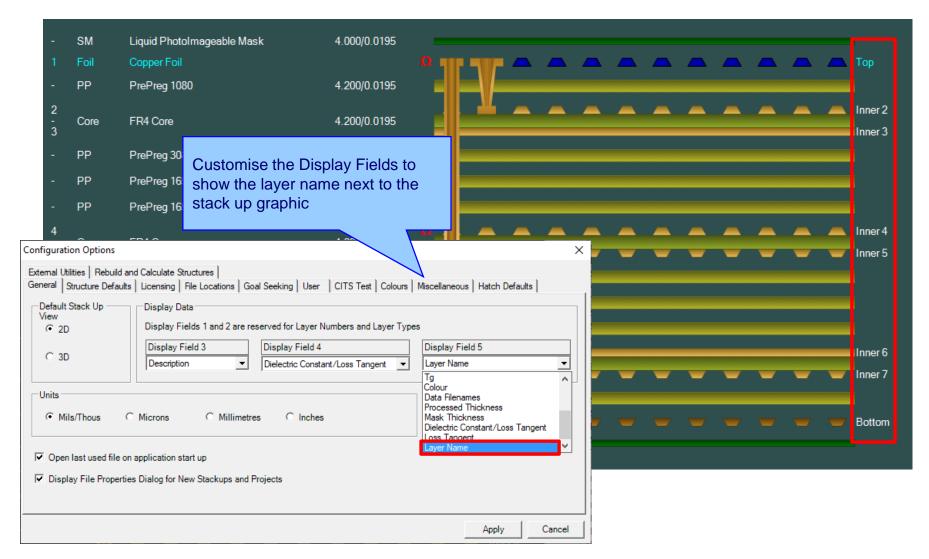
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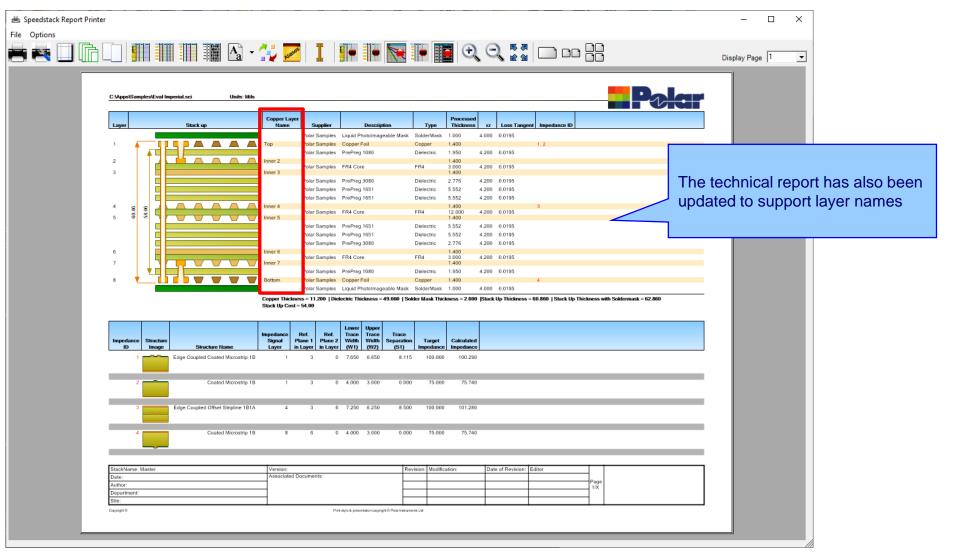


### New Layer Name property for electrical / copper layers





### New Layer Name property for electrical / copper layers





### **Copper Finishing classes increased**

Copper Coverage Based	d Prepreg Correction	s	×
Percentage Copper To Be	Embedded in Prepreg		
Set by Layer type			
Signal Layer	%	75	
Mixed Layer	%	15	
Plane Layer	%	5	
C Proportional to Covera	ge		
Copper Finishing			
Enter values of thickness the one added to the base	thickness of copper la	yers when plating.	
Enter values of thickness the one added to the base Class Name	thickness of copper la	yers when plating. Selection	
Enter values of thickness the one added to the base Class Name Class 1	Value	yers when plating.	
Enter values of thickness the one added to the base	thickness of copper la	yers when plating. Selection	
Enter values of thickness the one added to the base Class Name Class 1 Class 2	Value 0.7000 0.7000	yers when plating. Selection	
Enter values of thickness is the one added to the base Class Name Class 1 Class 2 Class 3	Value 0.7000 0.7000 0.7000	Selection	
Enter values of thickness is the one added to the base Class Name Class 1 Class 2 Class 3	Value 0.7000 0.7000 0.7000	Selection	
Enter values of thickness a the one added to the base Class Name Class 1 Class 2 Class 3 Class 4	Value 0.7000 0.7000 0.7000	Selection	

# Speedstack v21.04 and earlier supported 4 classes

Coj	pper Coverage Based Prep	preg Corrections			$\times$		
Perc	entage Copper To Be Embe	edded in Prepreg					
۰s	et by Layer type						
	Signal Layer	% 75			at a b	le pleting	~
	Mixed Layer	% 15		User sele thickness		• •	-
	Plane Layer	% 5		Options (			•
				Simple %	met	thods)	-
P	roportional to Coverage				$\checkmark$		
Copp	per Finishing						
Enter he o	r values of thickness accor ne added to the base thickr	ness of copper layers w	hen plating	_	1		
Enter he o	r values of thickness accor		hen plating	Edit			
Enter he o	r values of thickness accor ne added to the base thickn Class Name	Class Value	hen plating	_			
Enter he o ID 1	r values of thickness accor ne added to the base thickn Class Name Class 1	Class Value 0.7000	hen plating	Edit			
Enter he o ID 1 2	r values of thickness accor ne added to the base thickn Class Name Class 1 Rich	Iness of copper layers w Class Value 0.7000 0.8000	hen plating	Edit			
Enter he o ID 1 2 3	r values of thickness accor ne added to the base thickr Class Name Class 1 Rich Class 3	Class Value           0.7000           0.8000           0.7000	hen plating	Edit			

Speedstack v21.05 now supports 20 classes



### Import / Export enhancements

The following Import / Export options have been updated to support the layer name property introduced with Speedstack v21.05.06:

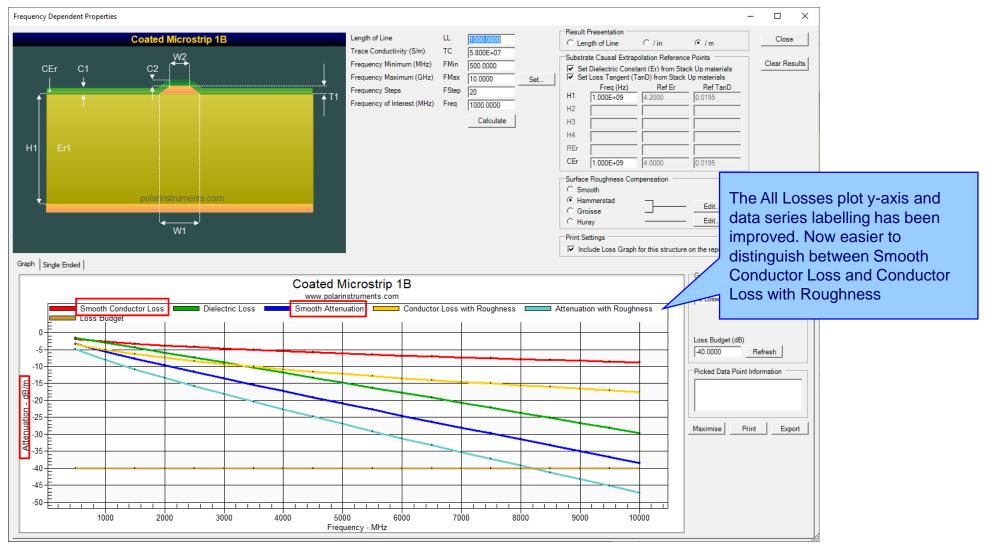
- XML STKX v21.00 and SSX v11.00 import / export options
- CSV export option
- Gerber / DXF export option



# Speedstack v21.04.00 (April 2021)



### All Losses plot - clearer labelling





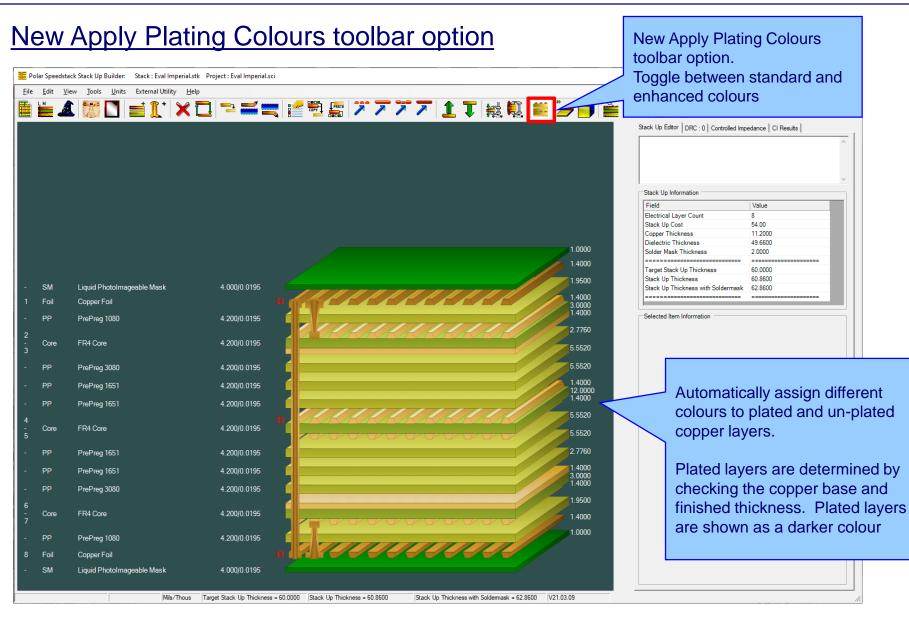
### Other enhancements

- The controlled impedance and insertion loss Calculation Engine updated to the latest edition
- Frequency Dependent Calculations graphing library enhancements



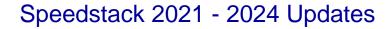
# Speedstack v21.03.09 (March 2021)





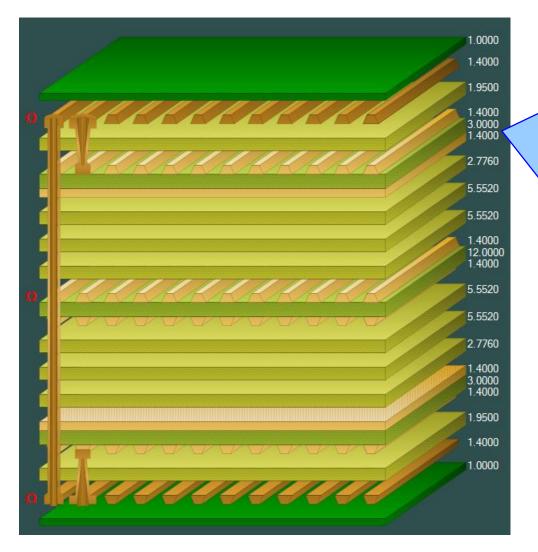
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### New Apply Plating Colours toolbar option



#### Plated Copper Layers

During PCB fabrication drill holes commonly have copper applied to the barrel wall by an electroplating process. This provides an interconnect between copper layers in the stack up.

This electroplating process often results in additional copper also being applied to the exposed copper layers where the mechanical drill starts / ends.

It is important to account for this additional plated copper thickness when calculating the overall stack up thickness and controlled impedance / insertion loss structures.

Speedstack has always allowed this additional plating thickness to be applied to the relevant copper layers. With v21.03 this has been enhanced further with automatic colour assignments to the plated and unplated layers

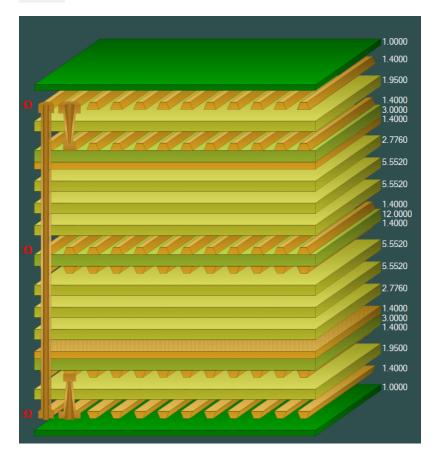
91



### New Apply Plating Colours toolbar option

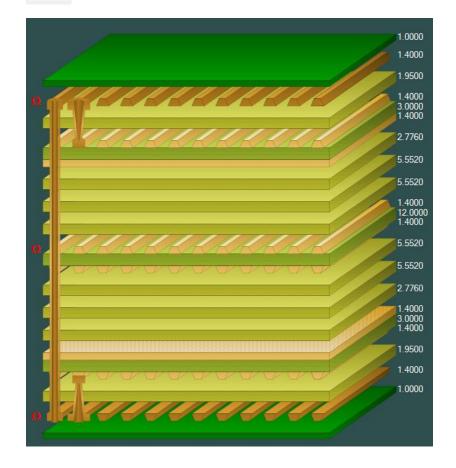


### **Standard Colours**





## Apply Plating Colours

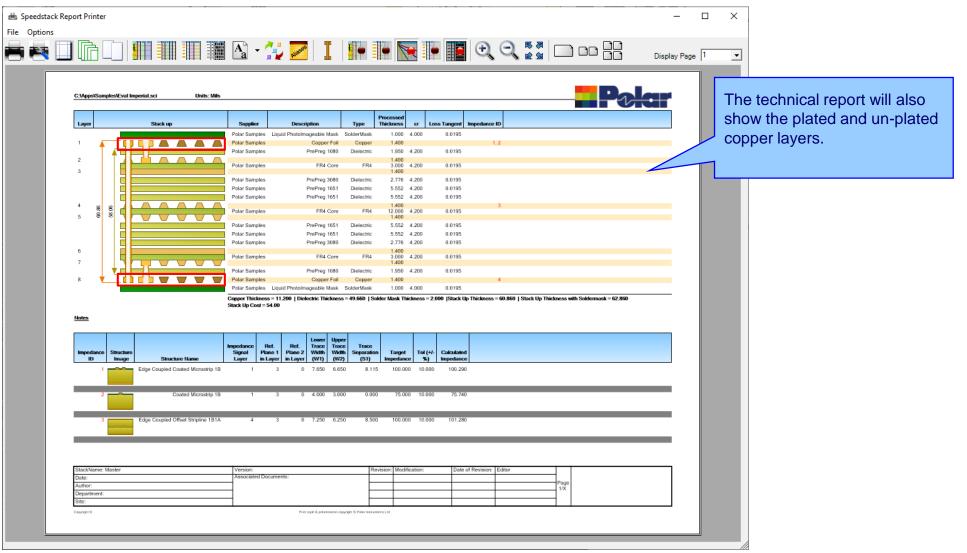


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92

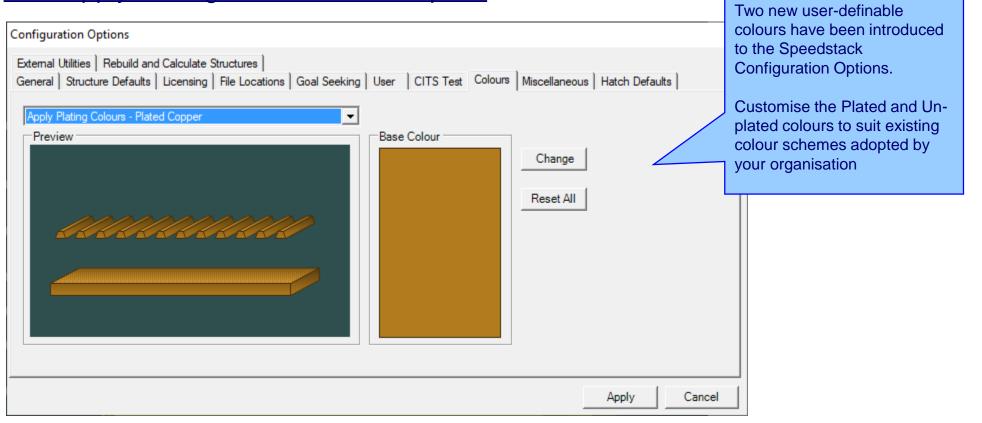


### New Apply Plating Colours toolbar option



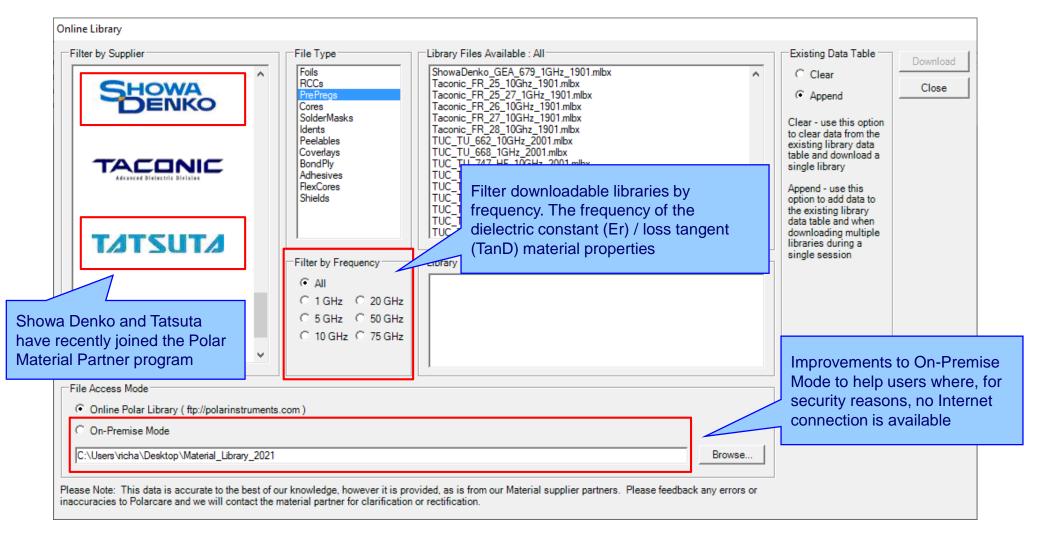


### New Apply Plating Colours toolbar option





### **Online Library enhancements**



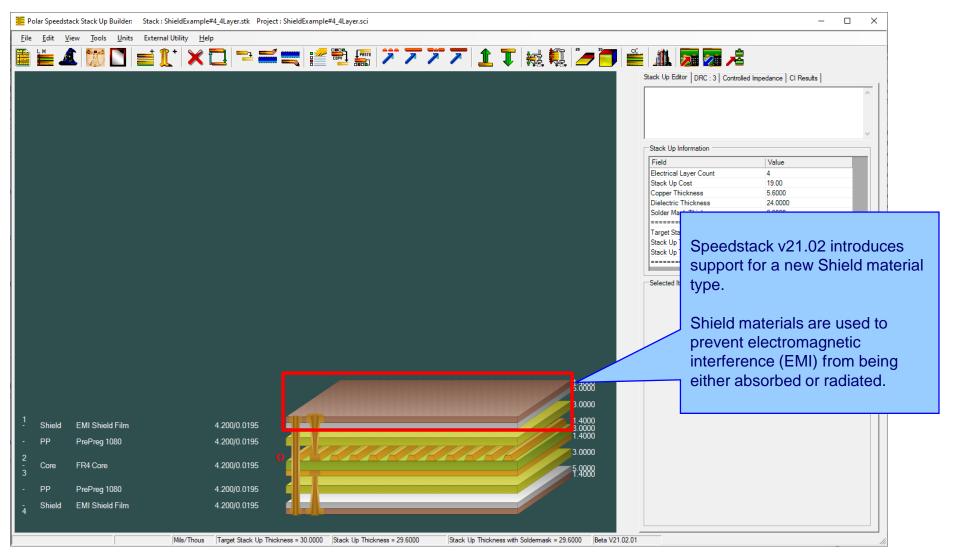
95



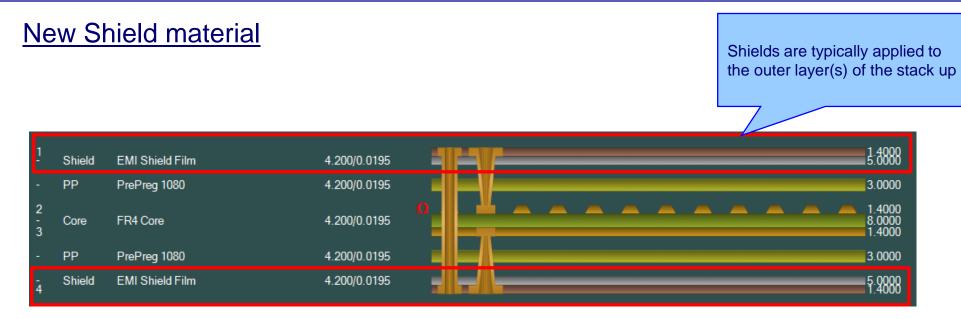
# Speedstack v21.02.01 (February 2021)



### New Shield material



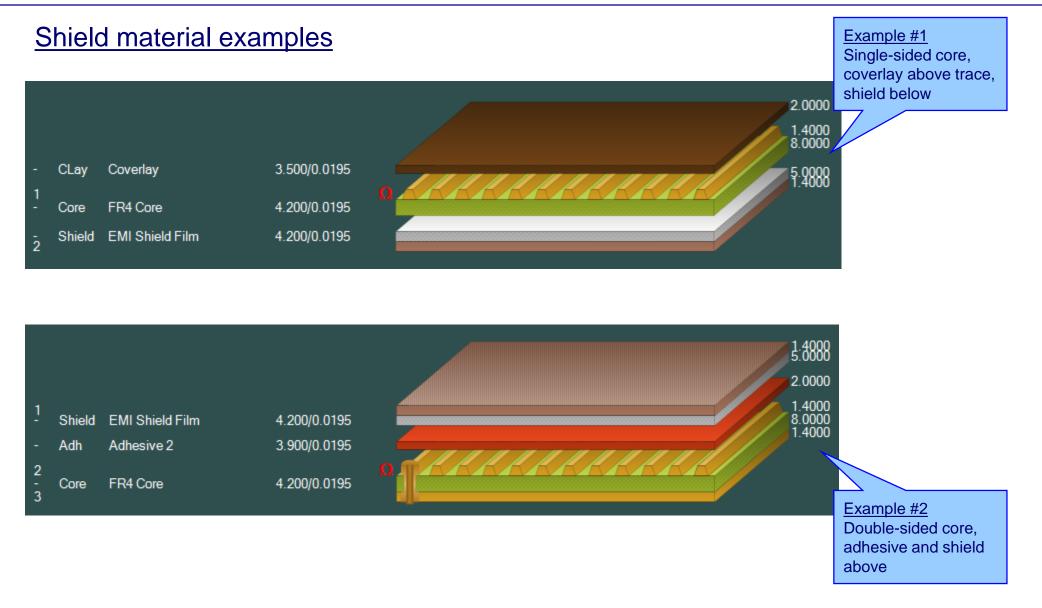




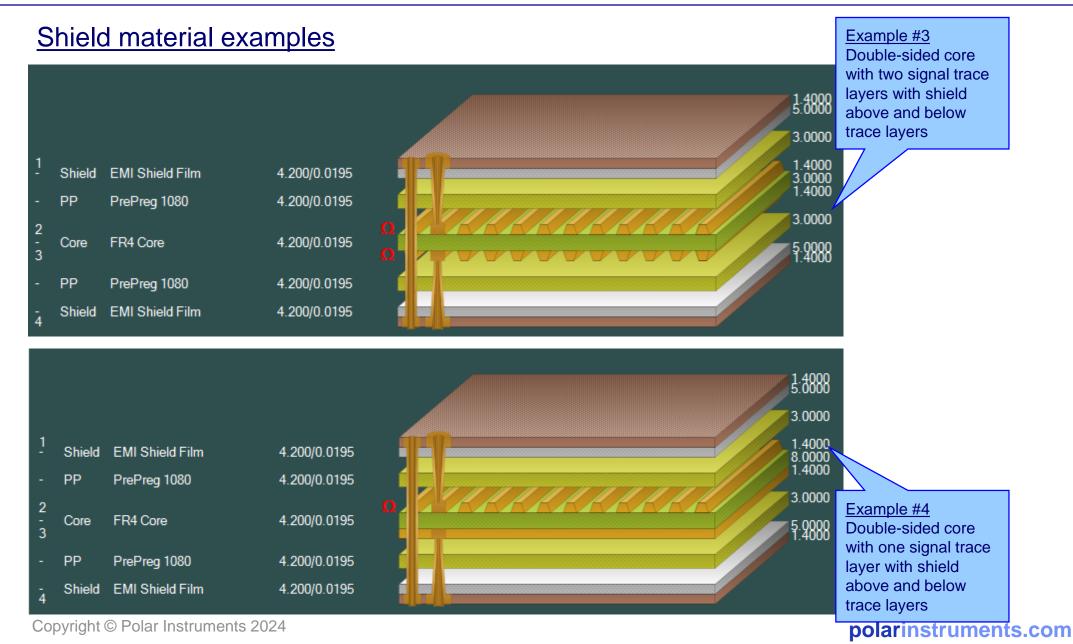




### Speedstack 2021 - 2024 Updates









### Material library enhancements

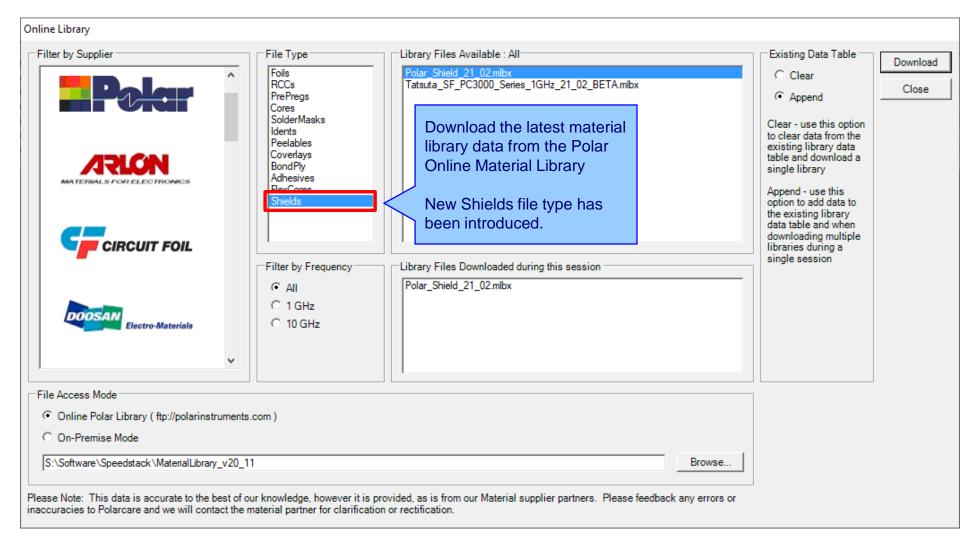
		eedstack Imperial.mlbx			Shield ma		ontains	
			<b>;</b>	🖌 🍋 🗟				
ils	Prepregs RCCs	s   Cores   Solder Masks   Ident	Inks   Peelable Masks   Coverlays   Bond Ply   Adhes	sive   Flexible Cores Shields				
	Supplier	Supplier Description	Description	Stock Number	Dielectric Base Thickness	Dielectric Finishe	ed Thickne Shield Cu Thickness	Diele
_	PolarSamples	SH/001	EMI Shield Film	1200-001	5	5	0.7	4.2
_	PolarSamples	SH/002	EMI Shield Film	1200-002	5	5	1.4	4.2
_	PolarSamples	SH/003	EMI Shield Film	1200-003	5	5	2.8	4.2
_	Polar Samples	SH/004	EMI Shield Film	1200-004	10	10	0.7	4.2
	Polar Samples	SH/005 SH/005	EMI Shield Film EMI Shield Film	1200-005	10	10	1.4 2.8	4.2
_	PolarSamples	SH/000	Elvir Shield Film	1200-008	10	10	2.0	4.2



Review/Edit Shield				Material library Edit Sl
Supplier	Polar Samples	Size	•	
Supplier Description	SH/001	Note 1		
Description	EMI Shield Film	Note 1		
StockNumber	1200-001			
Туре	Shield			
		Note 2		
Base Thickness	5.0000			
Finished Thickness	5.0000			
Dielectric Constant	4.2	Note 3		
Loss Tangent	0.0195			
Resin Content	0			
Tg	0			
Td	0	Note 4		
CAF Resistance	0			
Z Axis Expansion	0			
Excess Resin	0.0000	Note 5		
Tolerance +/-%	10			
Shield Copper Thickness	0.7000			
Cost	0			
Lead Time	0			
Laser Drillable				

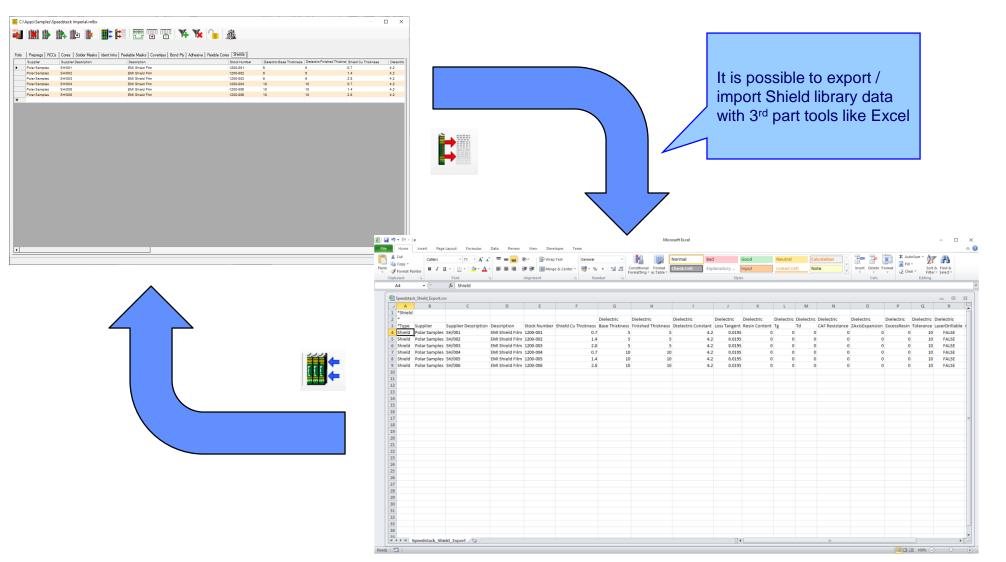


### Online Library enhanced to support Shield materials



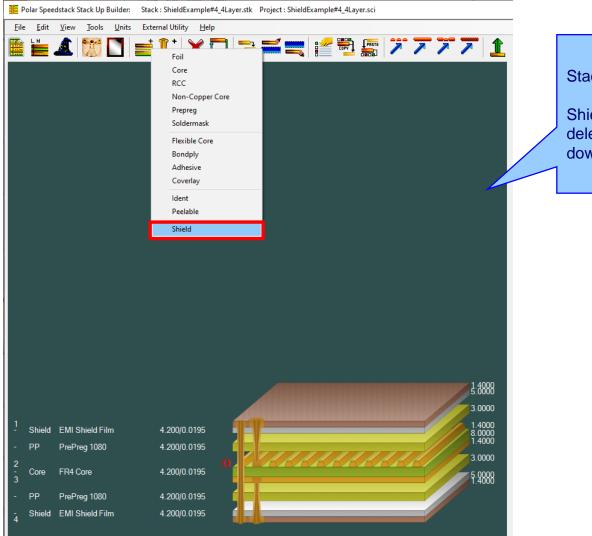


### Export / Import Shield library to Excel





### Stack up editor enhancements



Stack Up editor enhancements:

Shield material options to add, delete, swap, move up, move down, symmetry and set properties

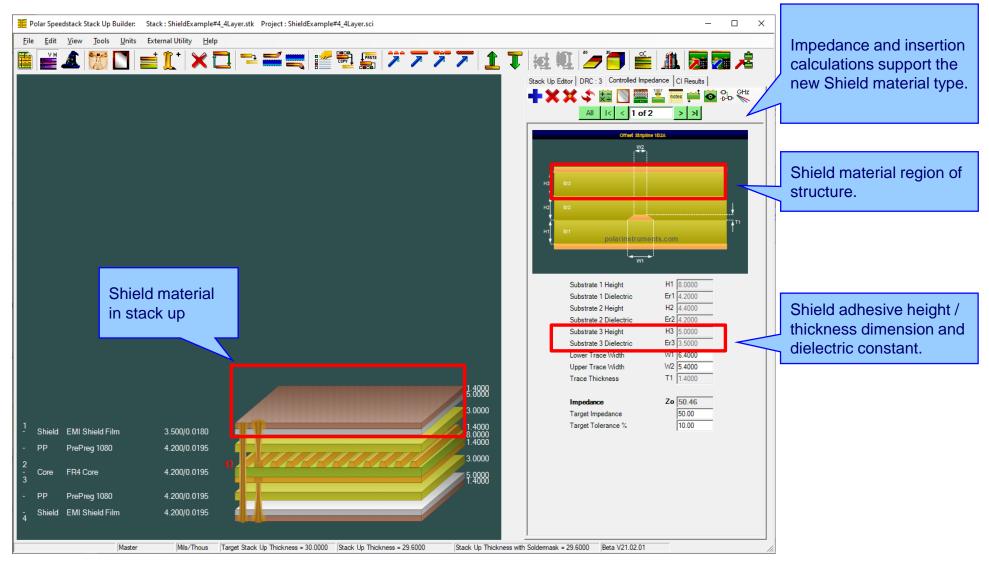


## Shield properties

<u>File Edit View Tools Unit</u>	ts External Utility <u>H</u> elp	.stk Project : ShieldExample#4_4Layer.sci			_		View and customise the Shield properties. Useful
🗎 🗾 🎊 🔔 📲	📑 🚺 🕈 🔁 👎	= 🛋 🗮 💒 🛃 🌆 🔰	77717	Fiel 🗓 🎽 🗂 I	🎬 🥼 🏹	<u>7</u> 📌 🖊	in 'what-if' scenarios
		Shield Properties					
		Main Notes Attributes					
		General Information				Apply	
		Supplier	Polar Samples			Cancel	
		Supplier Description	SH/002			Close	
		Description	EMI Shield Film			'	
		Stock Number	1200-002				
		Туре	Shield				
		Shield Copper					
		Base Thickness	1.4000	Copper Coverage %	0.00		
		Finished Thickness	1.4000	Graphical Colour			
		Data Filename					
		Trace Inverted	Г	Remove Copper	_		
		Finishing Applied	Γ	(disabled if structures or sul	o-stacks exist)		
		Shield Dielectric					
		Base Thickness	5.0000	Td	0.0		
		Finished Thickness	5.0000	CAF Resistance	0.0		
		Dielectric Constant	4.2000	Z Axis Expansion	0.0		
		Loss Tangent	0.0195	Excess Resin	0.0000		
		Resin Content %	0.00	Isolation Distance	5.0000		
		Tg	0.0	Graphical Colour			
				Data Filenames			1
1 - Shield EMI Shield Film	4.200/0.0195	1.410	1:4000				
	· ·			Dielectric Base Thickness Dielectric Finished Thickness	5.0000		
- PP PrePreg 1080	4.200/0.0195		3.0000	Dielectric Constant	4.2		
2 - Core FR4 Core	4.200/0.0195		1.4000 8.0000 1.4000	Loss Tangent Resin Content	0.0195		
3	1.200/0.0100	<u>μπ</u>	1.4000	Tg	0		
- PP PrePreg 1080	4.200/0.0195		3.0000	Td	0		
- Shield EMI Shield Film	4.200/0.0195		5:0000	CAF Resistance Z Axis Expansion	0		
4			1.4000	Excess Resin	0.0000	-	
	Mils/Thous Target S	Stack Up Thickness = 30.0000 Stack Up Thickness = 2	29.6000 Stack Up Thickness	with Soldermask = 29.6000 Beta V21.02	2.01	//	



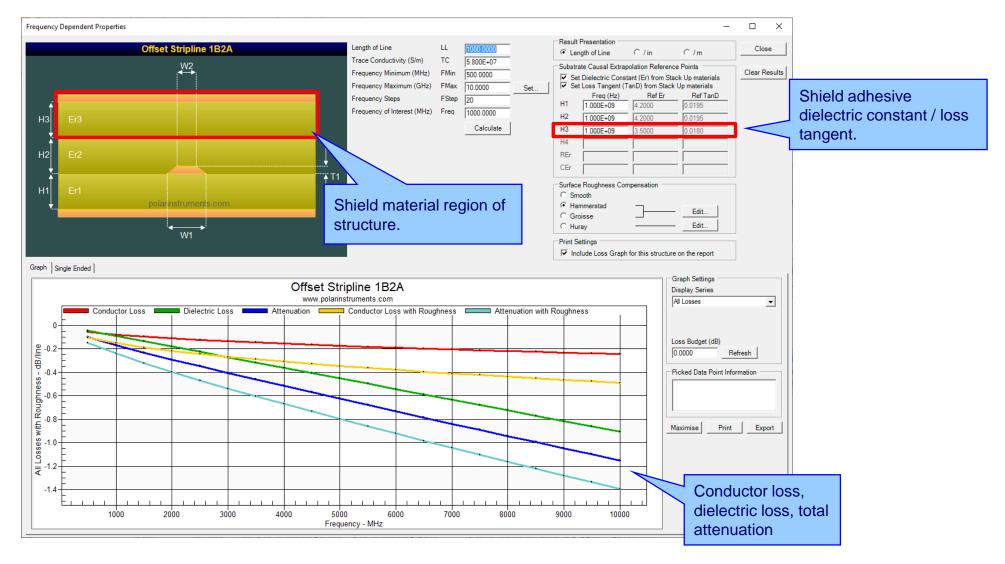
### Controlled impedance and insertion loss calculations



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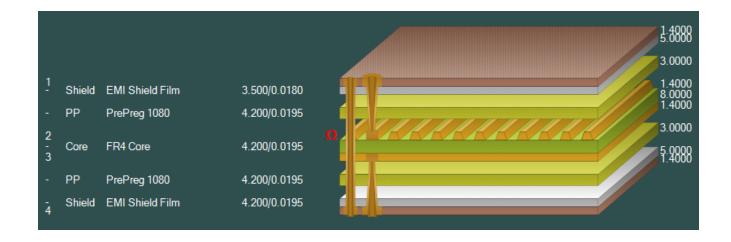
### **Controlled impedance and insertion loss calculations**



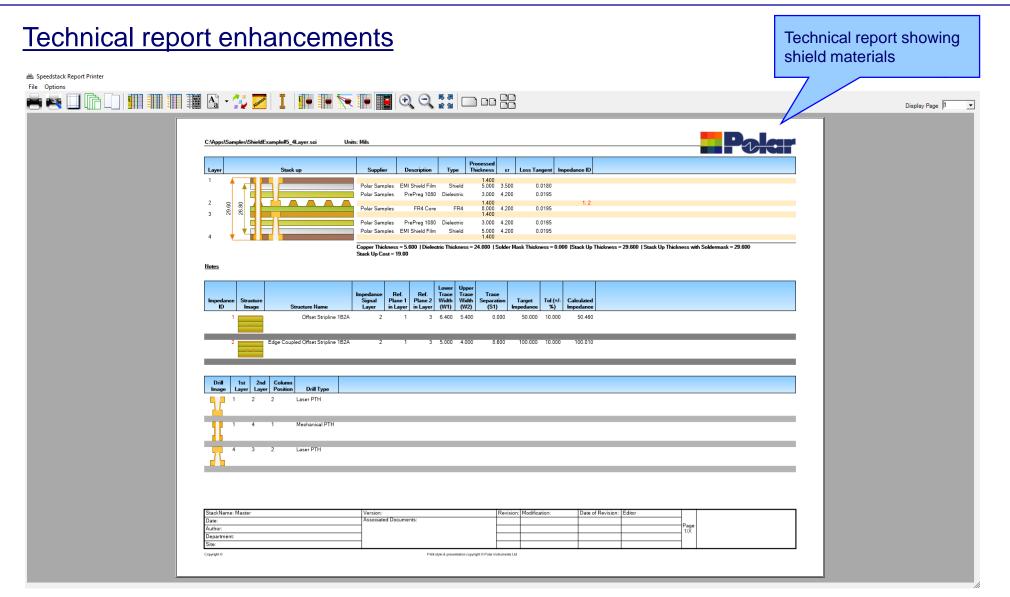


### Controlled impedance and insertion loss calculations

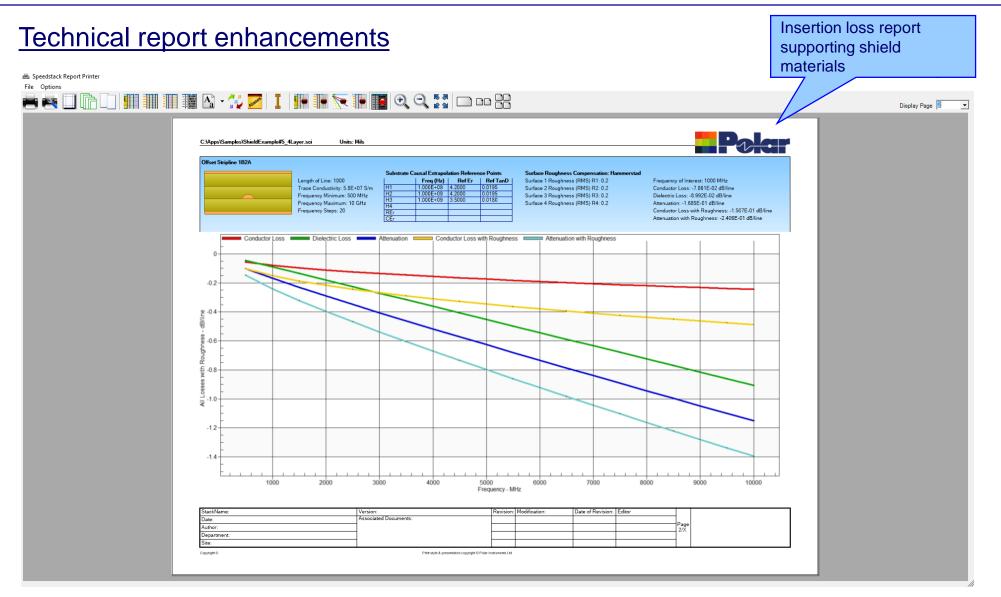
Please note: Speedstack is capable of supporting many shield types for stack up design and documentation. However, it is important to use the correct type of shield material for controlled impedance and insertion loss applications. They are often designated by the shield vendor as 'for high speed signal transmission applications'.











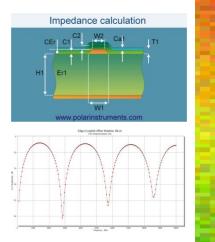


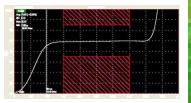
### Import / Export enhancements

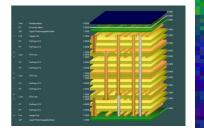
The following Import / Export options have been updated to support the new shield material introduced with Speedstack 2021:

- XML STKX v20.00 and SSX v10.00 import / export options
- CSV export option
- Gerber / DXF export option









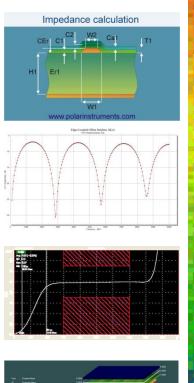


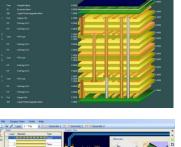
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Coated Microstrip 1B	Edge-Coupled Offset Stripline 1B1A1R	Surface Coplanar Strips With Ground 2B	Coated Coplanar Strips 2B	Diff Coated Coplanar Waveguide 2B	Dual Coated Microstrip 1B	Edge-Coupled Offset Stripline 2B1A1

For more information: Contact Polar now:	Phone
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